

Functional Coatings Prepared by Magnetron Sputtering for Innovative Applications

A. Fernández

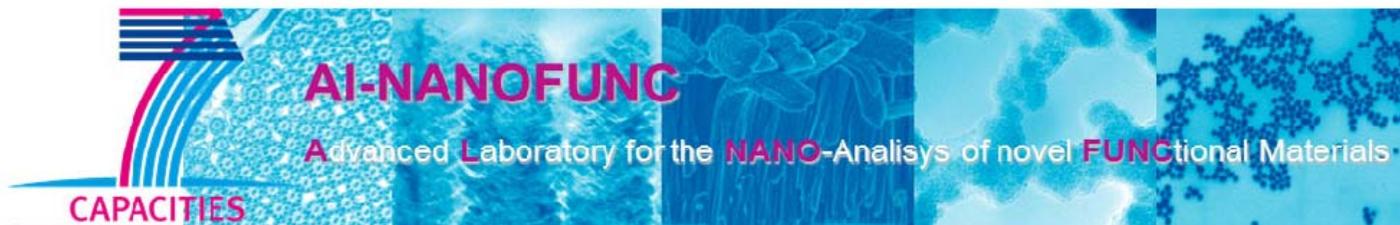
Instituto de Ciencia de Materiales de Sevilla, CSIC-Univ. Sevilla

LANE

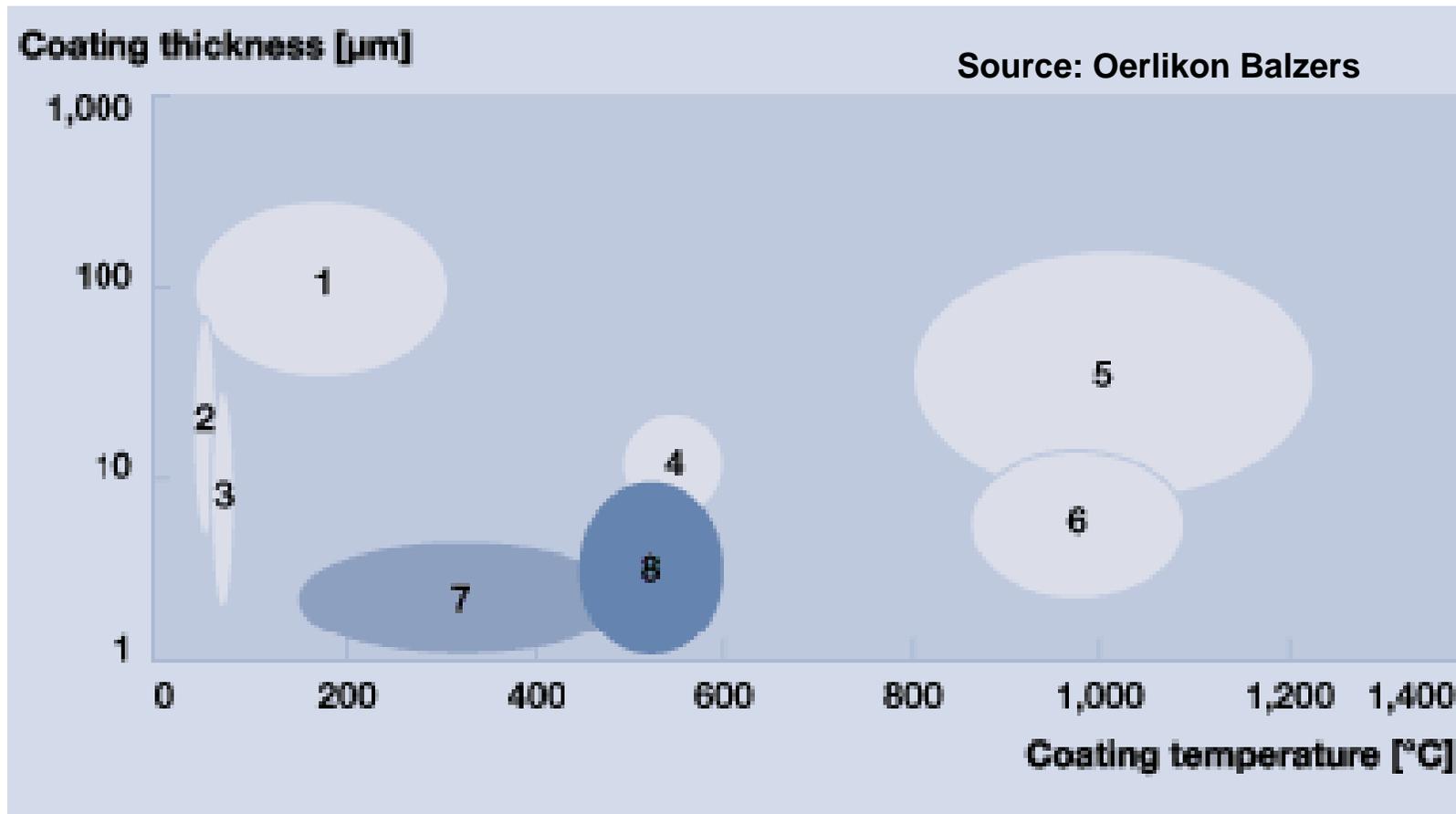
Laboratorio Avanzado de Nanoscopías y Espectroscopías

asuncion@icmse.csic.es

www.al-nanofunc.eu



FP7-REGPOT- 285895



1.- Plasma spraying

2.- Electrolytic and chemical deposition; 3.- Phosphating

4.- Nitriding; 5.- Boronising

6.- CVD; 7.- PVD, PACVD

8.- P3e™

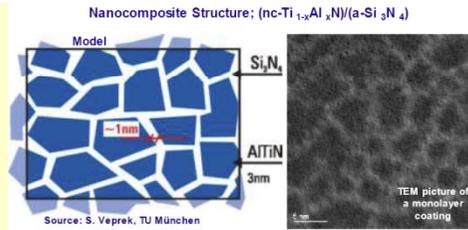
PVD = Physical Vapour Deposition. Magnetron Sputtering.

PACVD = Plasma Assisted Chemical Vapour Deposition

P3e™ = Based on arc evaporation using pulse technology (Balzers)

Broad fields of applications – Broad fields of expertise

Coatings for mechanical parts applications: Hard & Super-hard, tribological and wear resistant. Protective coatings (corrosion)



Nanocomposites nc-TiN/a-Si₃N₄



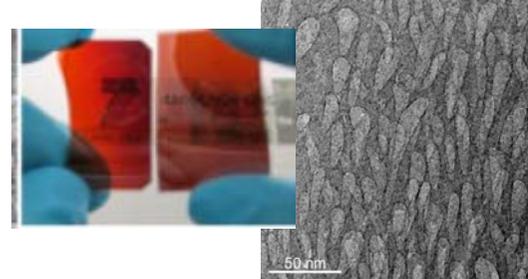
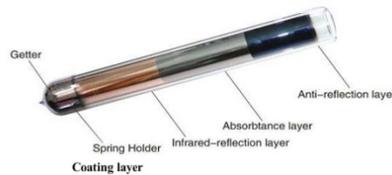
Generic Concept for the Design of Superhard Nanocomposites

- Binary (ternary, ...) system with a strong thermodynamically driven, spinodal segregation
- All phases strong materials, Si is not in the metallic phase.



Interference colour

Cermet-based selective surfaces



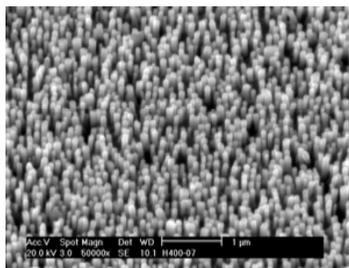
Porous α -Silicon

Optical coatings: Decorative, refraction index and reflectivity control. Cermet-based selective surfaces

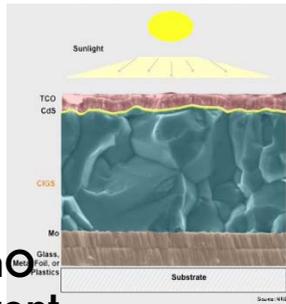
Functional: Electrical and optical

Catalytic coatings, self-cleaning

Biocompatible & Bio-functional coatings

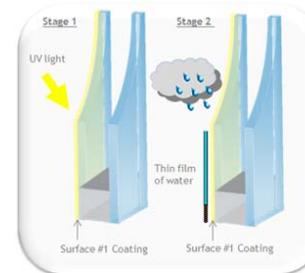
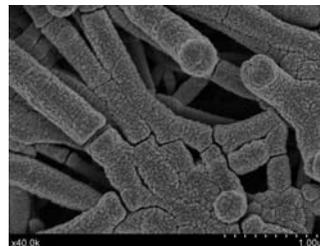


Thin film Photovoltaic



vertically aligned ZnO Nanowires. Transparent & conductive coatings

Co catalysts for H₂ generation

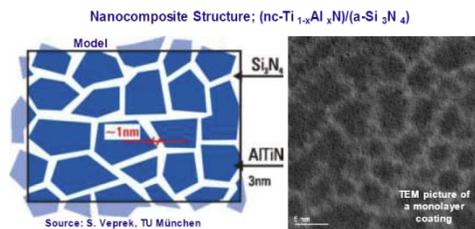


TiO₂ based self-cleaning coating



TiN, DLC, multi-component TiC, (Ti,Ta)C-based coatings

Coatings for mechanical parts applications: Hard & Super-hard, tribological and wear resistant. Protective coatings (corrosion)



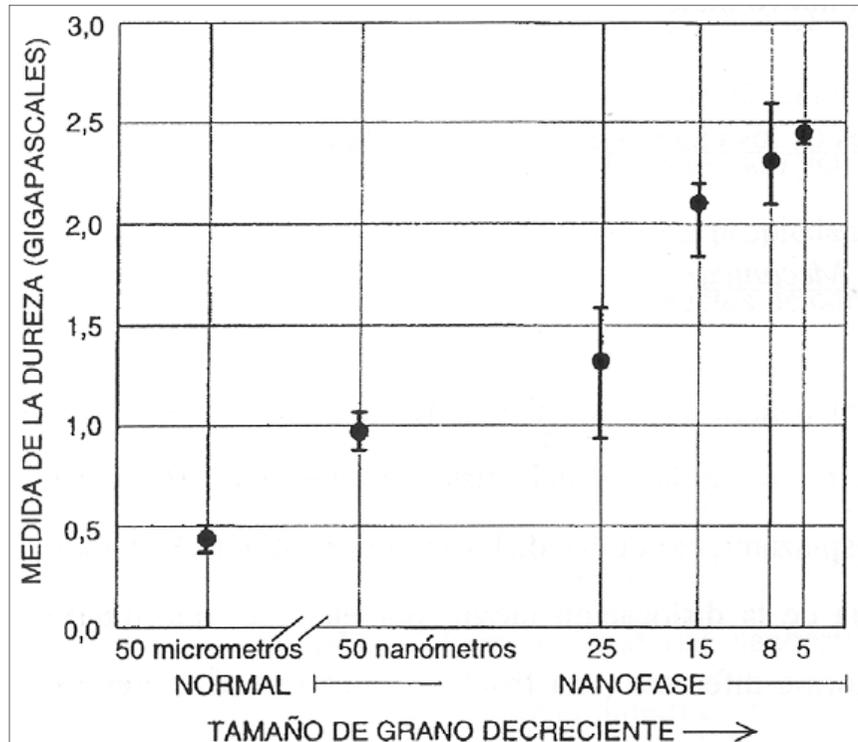
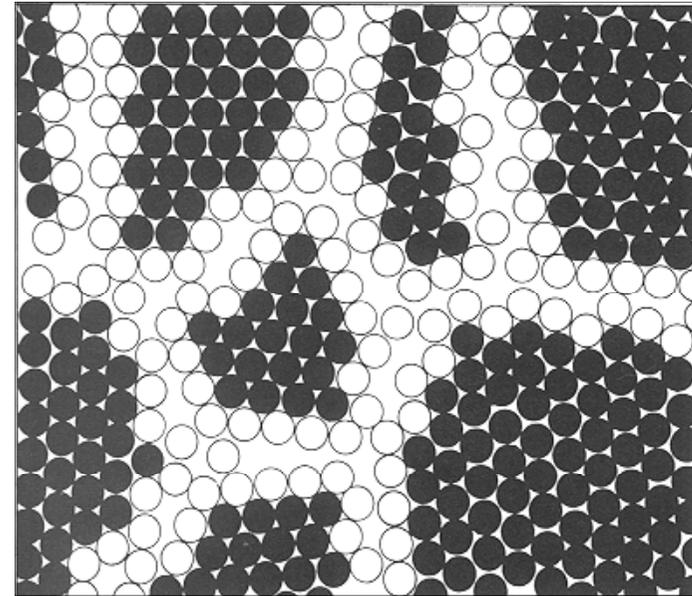
Generic Concept for the Design of Superhard Nanocomposites

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- All phases strong materials, Si is not in the metallic phase.

Nanocomposites nc-TiN/a-Si₃N₄



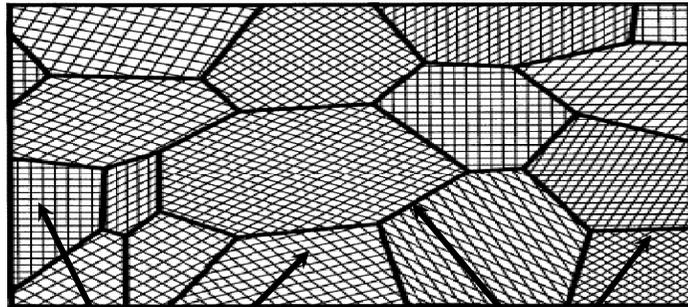
Nanocrystalline materials. Bulk materials obtained for example by consolidation of nanometric powders or by ball milling. They contain nanocrystalline grains and a big amount of grain boundaries.



Hardness measurements for nanocrystalline copper as a function of grain size (6-50 nm). Comparison to a conventional Cu sample (50 μm grain size).

Increase of hardness by reduction of grain size.

Polycrystalline materials



Crystals

Grain boundaries

Hall-Petch effect

$$\sigma_c = \sigma_0 + \frac{k}{d^{1/2}}$$

Hardness (σ) increases as grain size (d) decreases. Dislocations are not propagated at grain boundaries. Deformation (i.e. indentation) produces dislocations that are stopped at the grain boundaries. The decrease in grain size produces an increase in the number of grain boundaries.

Reverse Hall-Petch effect.

The grain boundaries sliding produces propagation of dislocations

J. Schiotz, F.D. Di Tolla, K.W. Jacobsen,
Nature, 391 (1998) 561

**BUT: If $d \downarrow \downarrow \Rightarrow \downarrow s_c$
Sliding of grain
boundaries appears**

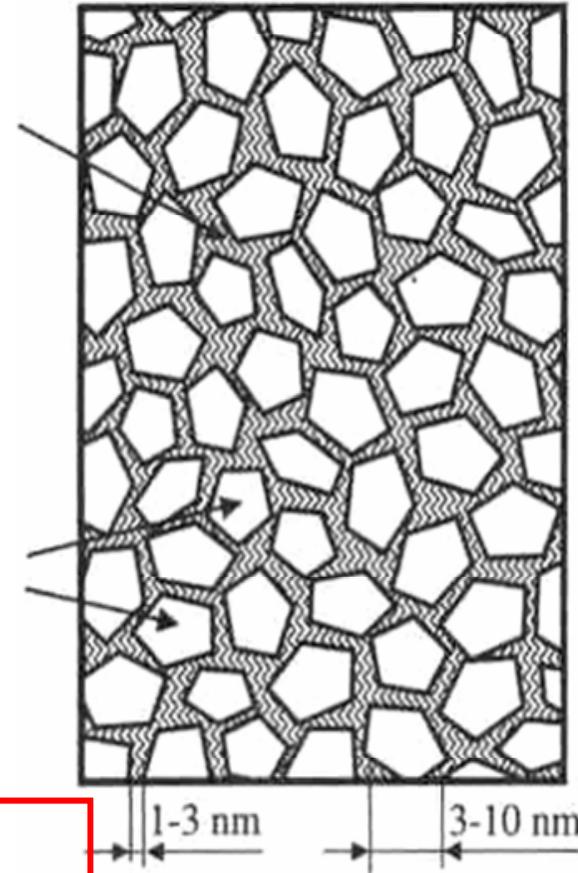
“Nanocomposite” hard coatings



Amorphous matrix
(ceramic, carbon, metal)



Nanocrystals (hard phase)
(nitrides, carbides, borides)



The amorphous phase avoid the grain boundaries sliding and hardness increases overcoming the reverse Hall-Pecht effect.

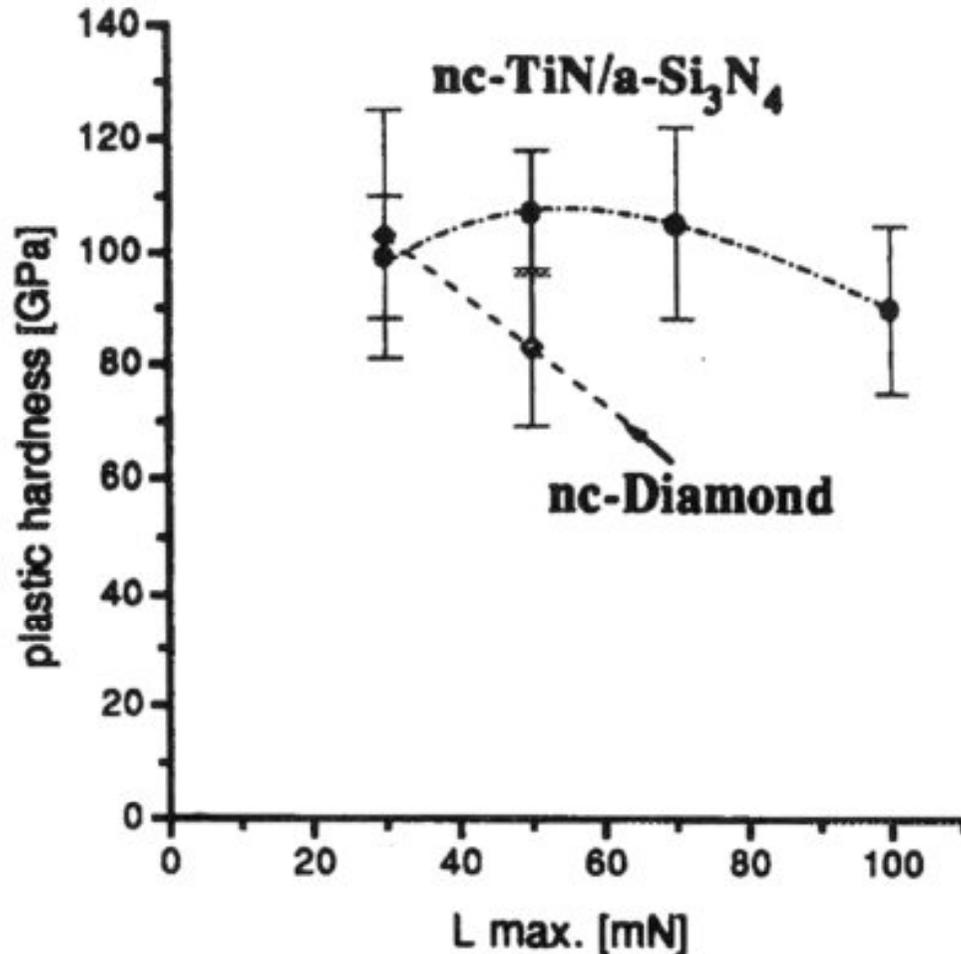
S. Vepřek, J. Vac. Sci. Technol. A 17 (1999) 2041

P. Nesládek & S. Vepřek, Phys. Stat. Sol. 177 (2000) 53

i.e. System: nc-TiN/a-Si₃N₄

S. Vepřek, J. Vac. Sci. Technol. A 17 (1999) 2041

P. Nesládek & S. Vepřek, Phys. Stat. Sol. 177 (2000) 53



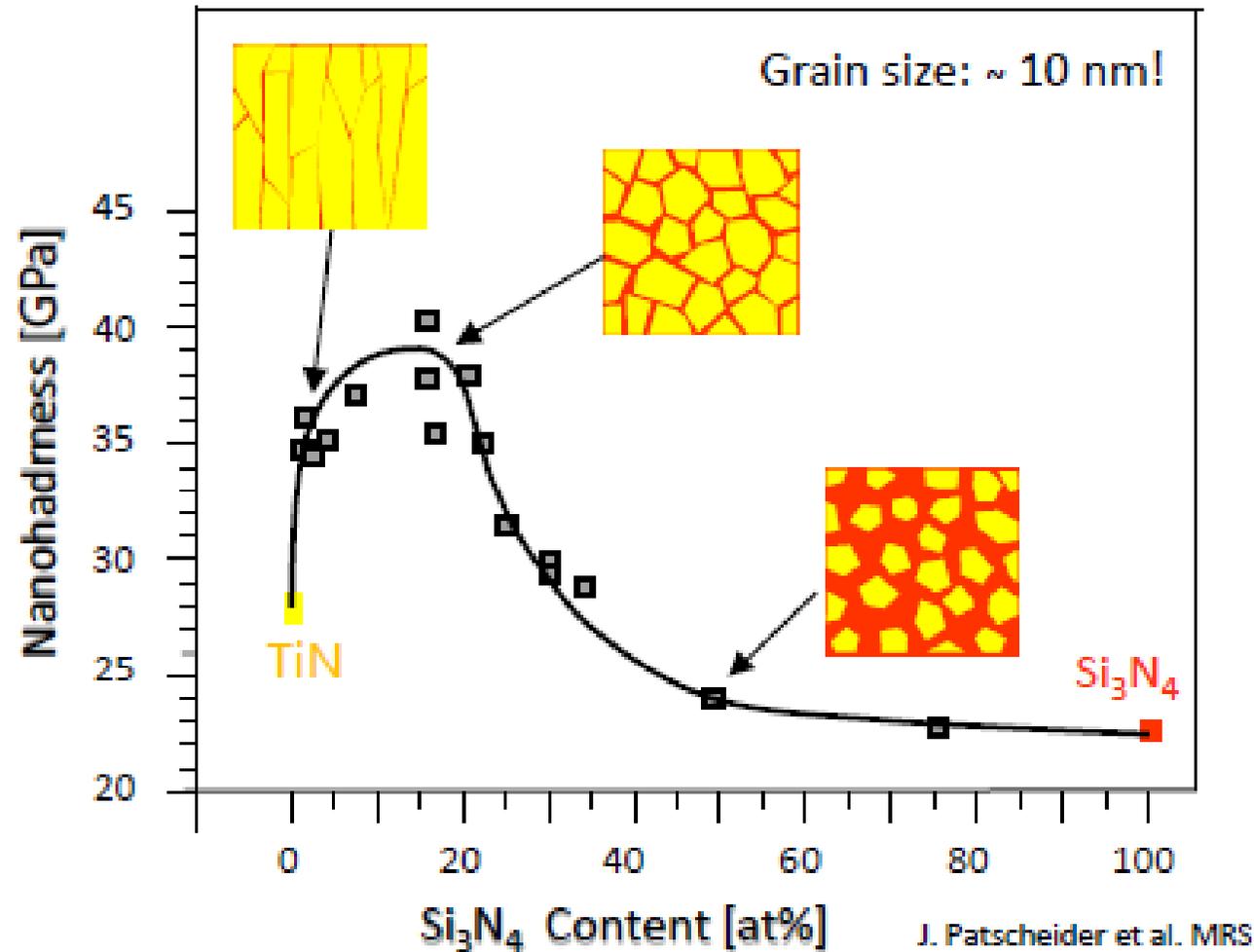
**Hardness
40-90 GPa**

Spinoidal phase segregation
two immiscible materials completely segregate with sharp interfaces.

To avoid lattice misfit one of the phases should be amorphous

**Nanocrystals ($\varnothing = 3-10$ nm)
Amorphous matrix ($t = 1-3$ nm)**

Superhard n-c:TiN/Si₃N₄ Coatings



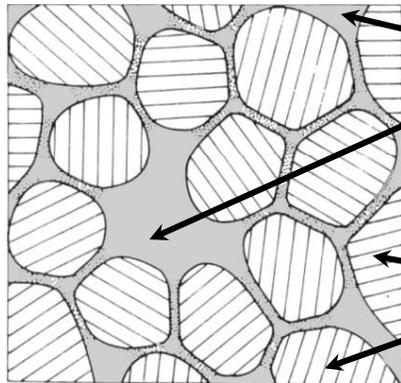
J. Patscheider et al. MRS Bulletin 28/3, 180 (2003), APL 96, 071908 (2010)

Multifunctional coatings.

“Nanocomposite” material which combine hardness with corrosion resistance. High speed machining. High temperatures working operation

- Coatings with a **nanocomposite microstructure**: nc-TiAlN/ α -Si₃N₄ or nc-CrAlN/ α -Si₃N₄

Nanocomposite



α -Si₃N₄
(ceramic amorphous phase)

TiAlN, CrAlN
(hard phase)



Composition
&
Microstructure



Properties

Role of
impurities

Effect of dep.
conditions

Oxygen incorporation

Localization

Effect of temperature

Morphology

Growth mode

Composition

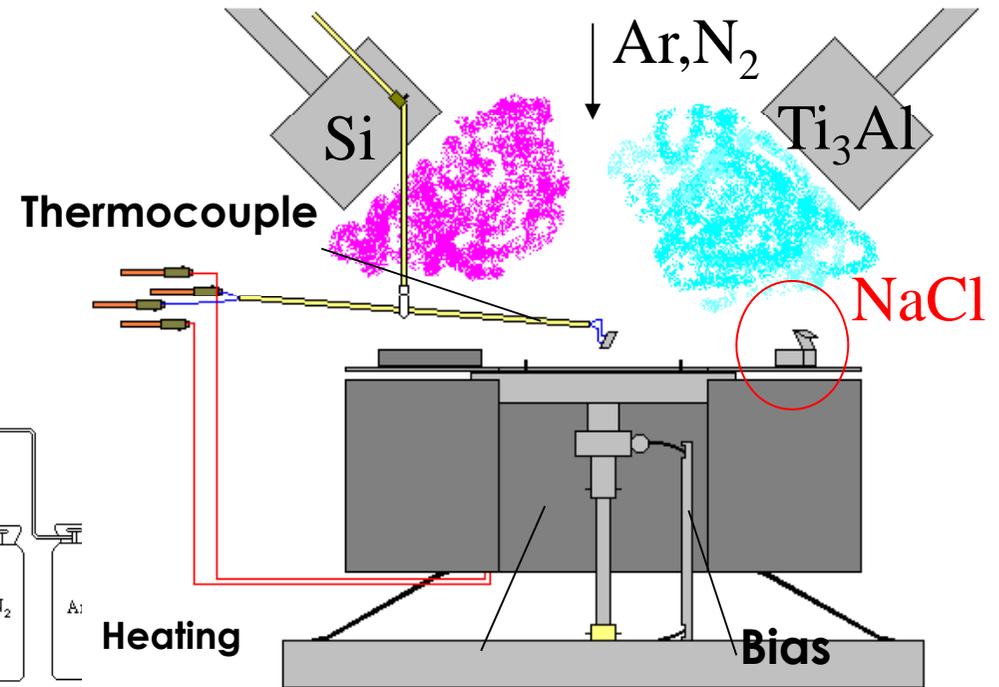
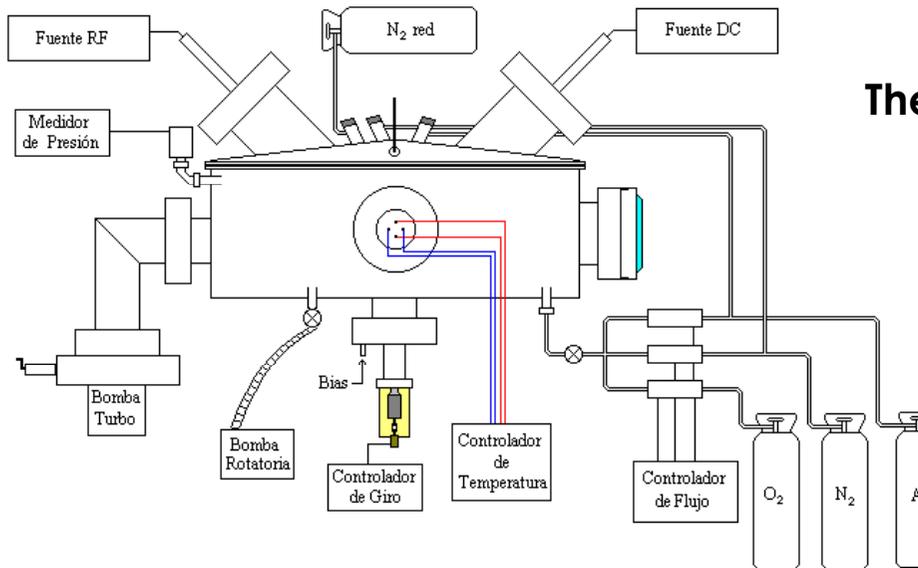
Microstructure

Our approach: Magnetron sputtering with Ti-Al and Si targets. N₂ reactive plasma.

S. Veprek: Mainly vacuum arc approach.

The deposition chamber

- “Magnetron Sputtering”



DC power supply: Up-to 1000W

RF power supply: Up-to 300W

Sample holder: Rotable, heatable, bias option.

Ti₃Al: 100-600 W DC; Si: 250 W RF

Bias: 0.25W in RF

Substrated temperature: 90°C and 300°C

Working pressure: 1.33 Pa N₂

TiAlSiN(O)/600-250/b-300°C
Bias and high T improve reduction
of oxygen content and favour
spinoidal segregation

2-10 nm **crystals**

amorphous matrix 0.5-1.2 nm

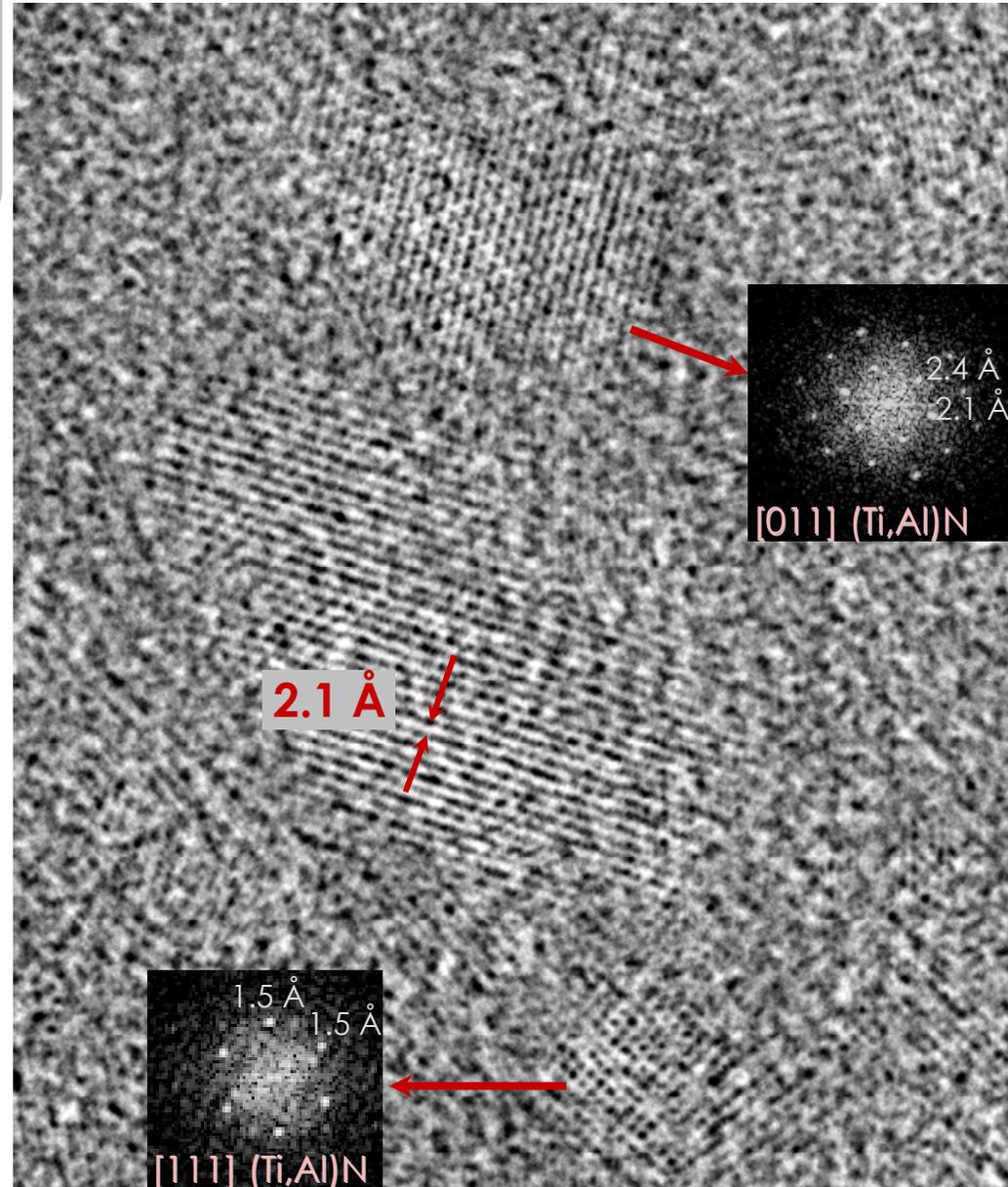
2.1 , 2.4 , 1.5 Å

{200}, {111}, {202}

fcc TiN-based

Al if incorporated is
occupying Ti positions in a
non-ordered way

30 GPa. Substrate T 300°C.
Not a complete spinoidal phase
segregation . Still too much
amorphous phase



TiAlSiN(O)/600-250
No bias and no high T
Columnar structure and higher
Oxygen content

**Electron Microscopy.
Energy Filtered TEM**

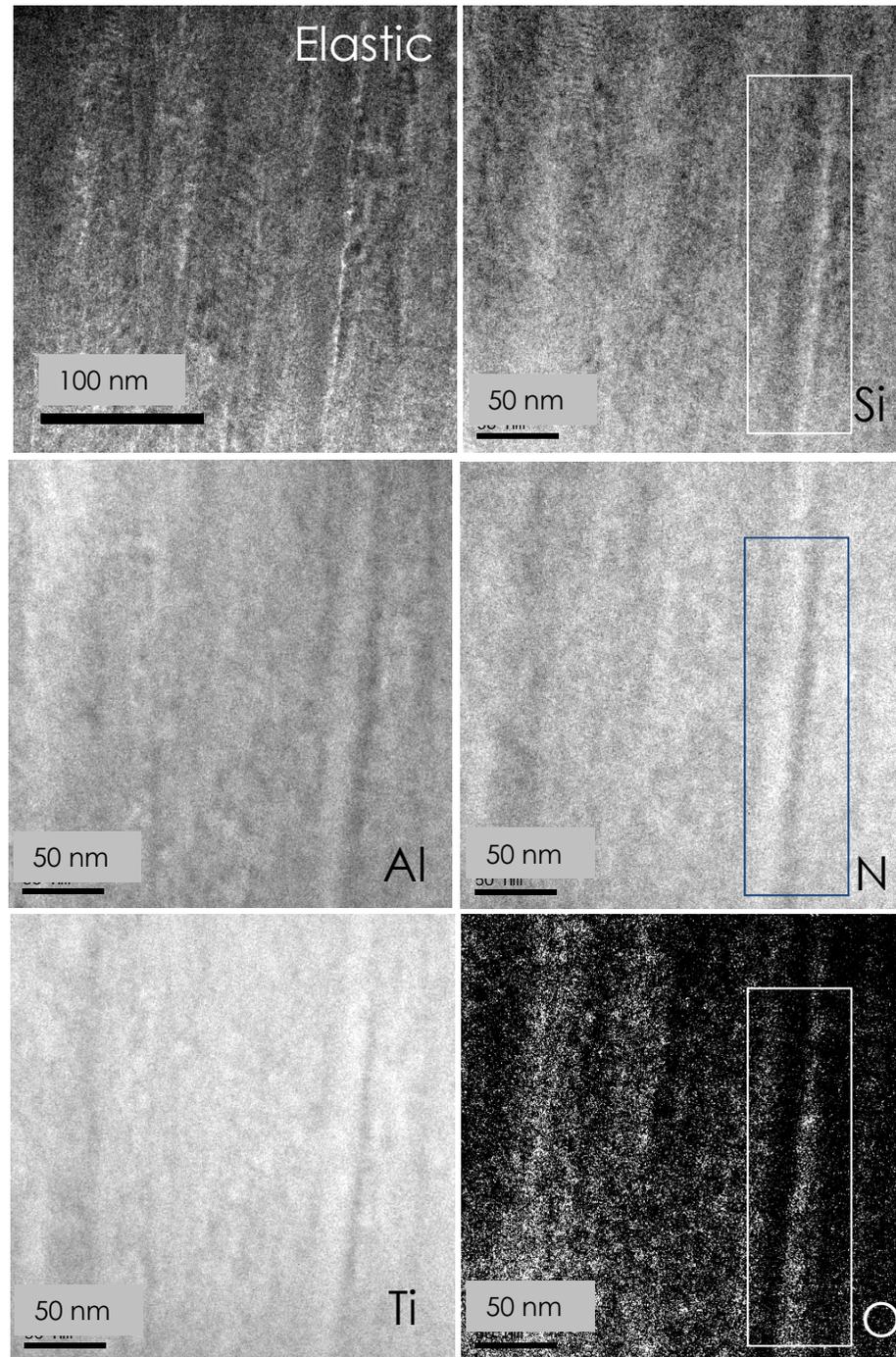
White zones higher
intensity of that element

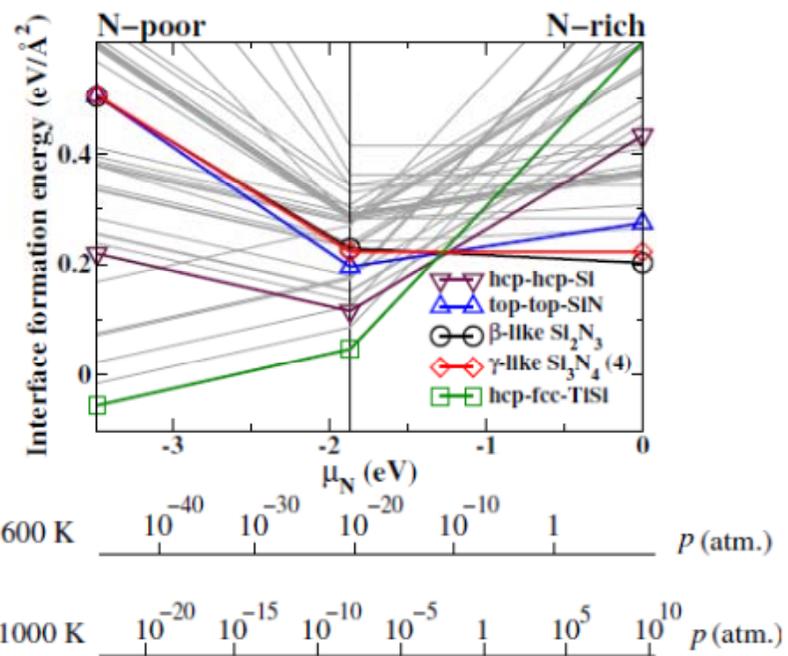
Columns are rich in:
Ti, Al, N

Interface area:
Si, O

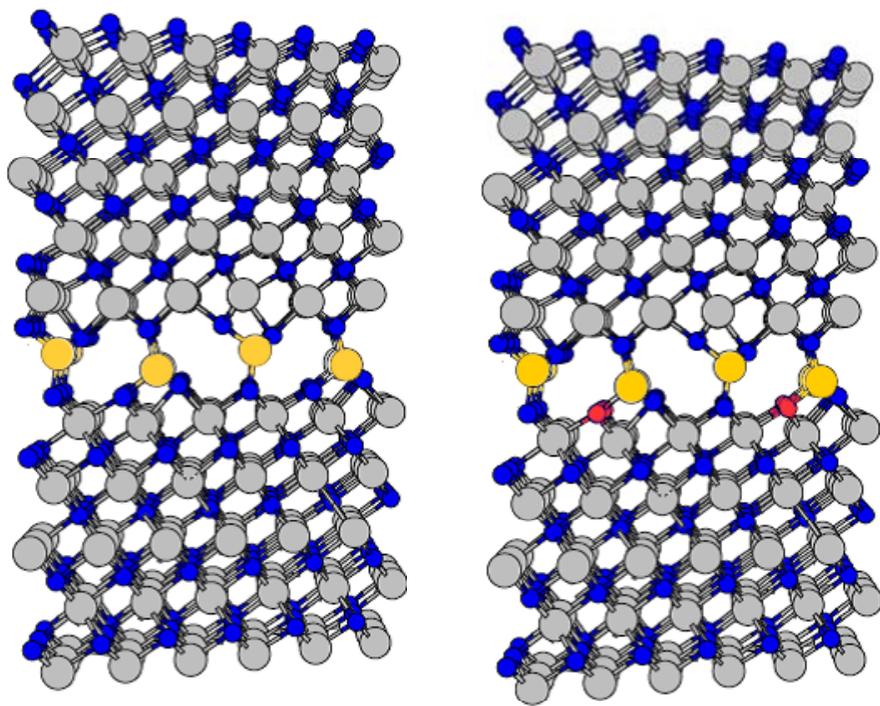
Inner core rich in Si-O
surrounded by Si-O-N

V.Godinho, T.C. Rojas, A. Fernández
et al, *Microscopy & Microanalysis*
18, 2012, pp 568-581



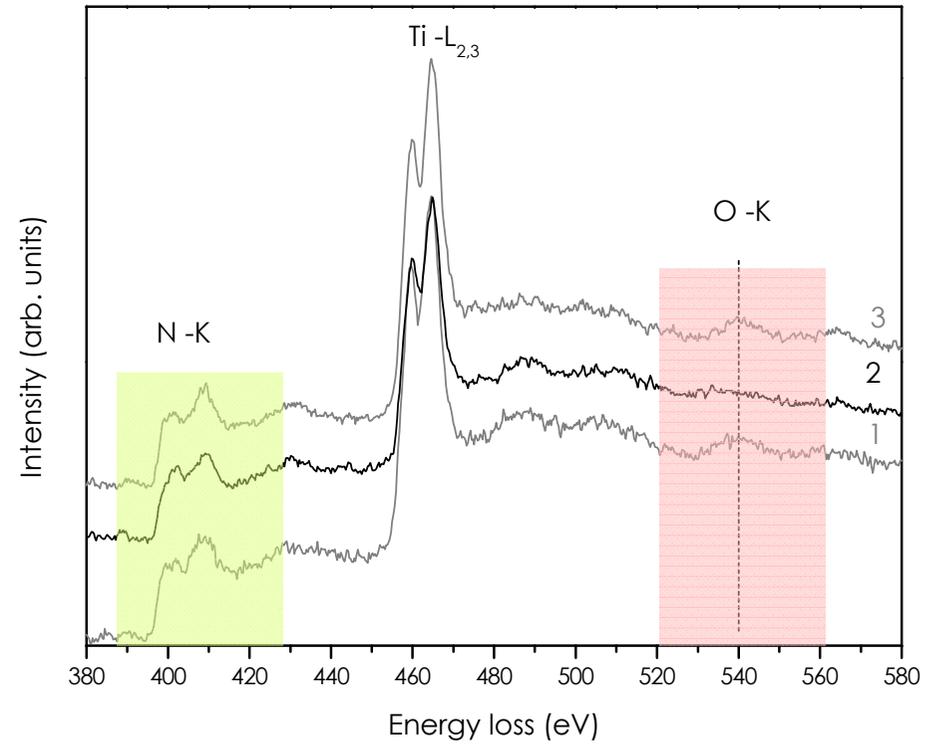
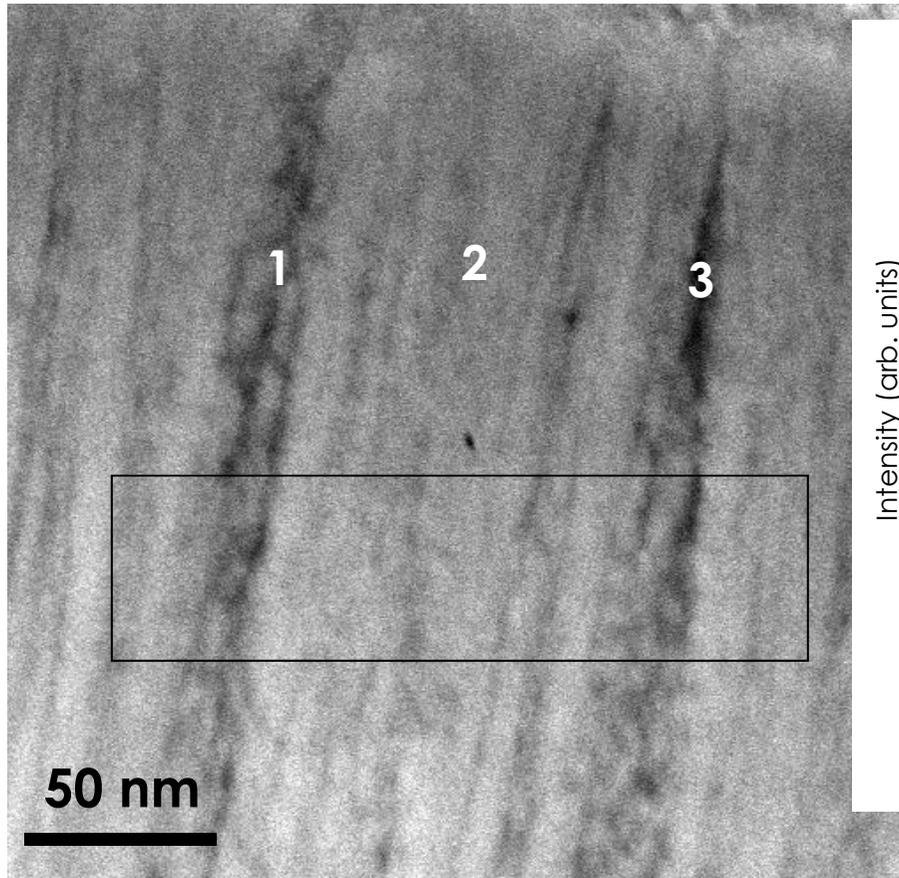


N-rich: β-like Si₂N₃



○ titanium ● silicon ● nitrogen ● oxygen

HAADF/STEM



TiAlSiN(O)/600-250

V. Godinho, T.C. Rojas, A. Fernández et al, *Microscopy & Microanalysis* 18, 2012, pp 568-581

N-O-Ti

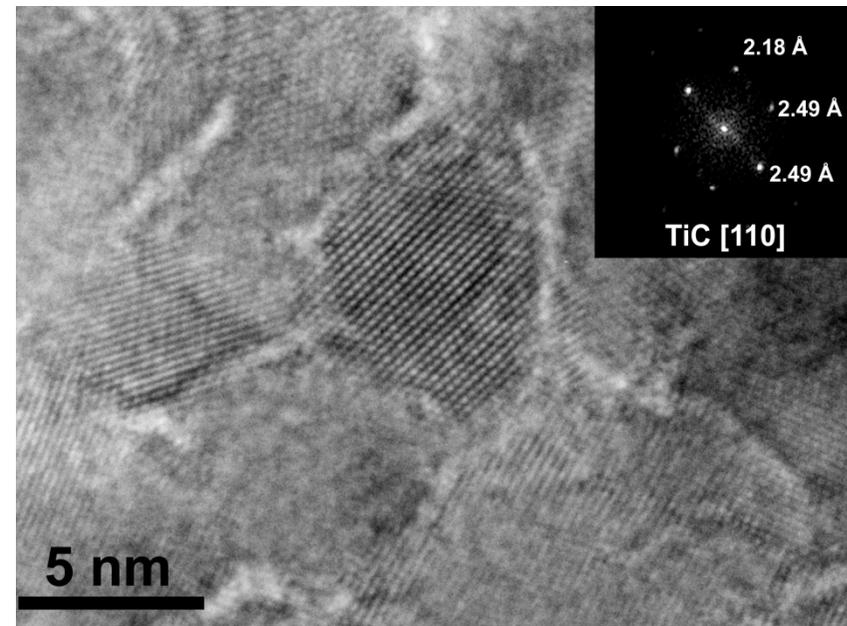
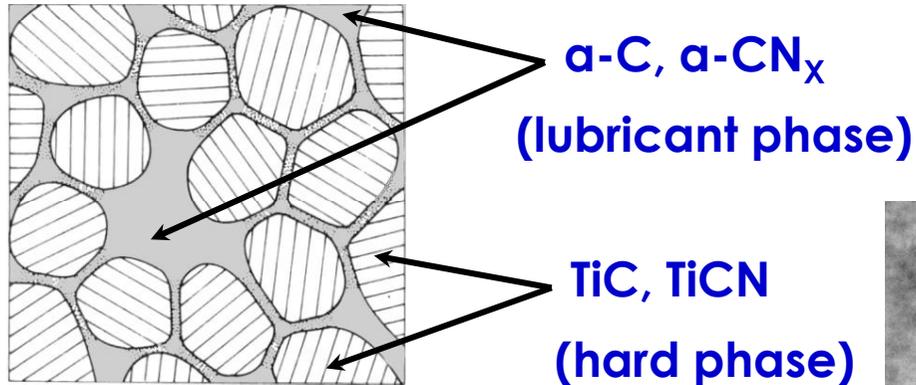


Multifunctional coatings.

“Nanocomposite” material in which the amorphous phase is a lubricant.

- Coatings with a **nanocomposite microstructure**: nc-TiC/ α -C or nc-TiCN/ α -CN_x a combination of hardness and low friction.

Nanocomposite



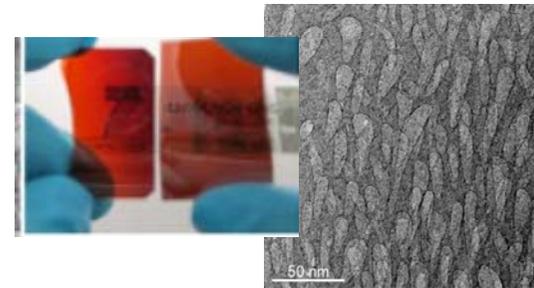
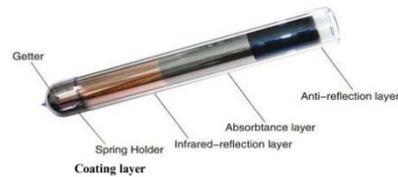
D.Martínez, A.Fernández, J.C.Sánchez-López et al.,
J.Vac.Sci.Tech.A, 23, 2005

Optical coatings: Decorative, refraction index and reflectivity control. Cermet-based selective surfaces



Interference colour

Cermet-based selective surfaces



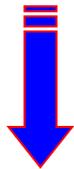
Porous α -Silicon

Interference coloured. When the **thickness of a coating is of the order of the wavelengths of the incident light**, the coating /substrate system can have remarkable reflective properties due to light wave interference and the difference in refractive index between the layer, the air, and the substrate. This effect, known as **thin-film interference**, can be used either on a single coatings or also in multilayered coatings.

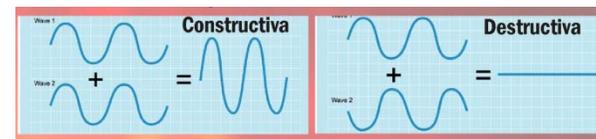
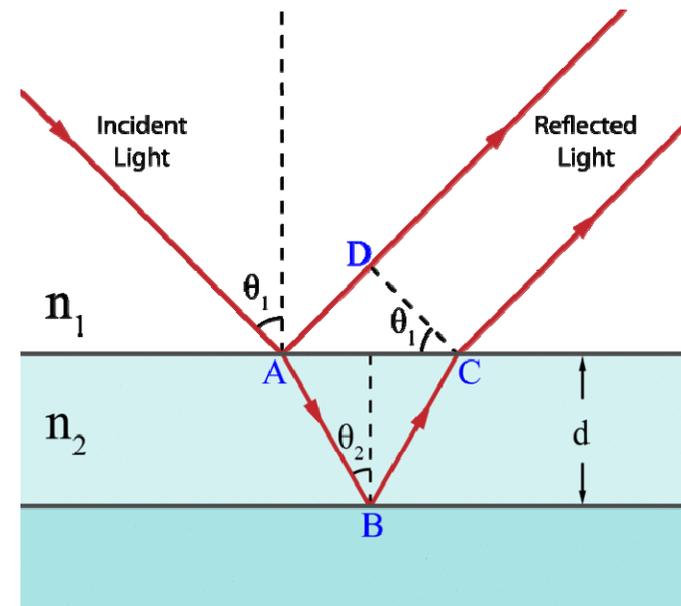
More general periodic structures, not limited to planar layers, are known as **photonic crystals**.

When light moves from a medium of a given refractive index n_1 into a second medium with refractive index n_2 , both reflection and refraction of the light may occur. **The Fresnel equations** describe what fraction of the light is reflected and what fraction is refracted (i.e., transmitted). They also describe the phase shift of the reflected light.

The light reflected from the upper and lower surfaces will interfere. The degree of constructive or destructive interference between the two light waves is dependent upon the difference in their phase. This difference is dependent upon **the thickness** of the film layer, **the refractive index** of the film, and **the angle of incidence** of the original wave on the film.



Structural colour





Magnetron sputtering provides a versatile method with a large selection of materials and excellent adhesion. Plastic covers with PVD coated with optical coating making optical, interference color effect.

(CenCorp Corporation)

Optical interference filter coatings produced by **Dual Magnetron Reactive Sputtering (DMRS) technology.**

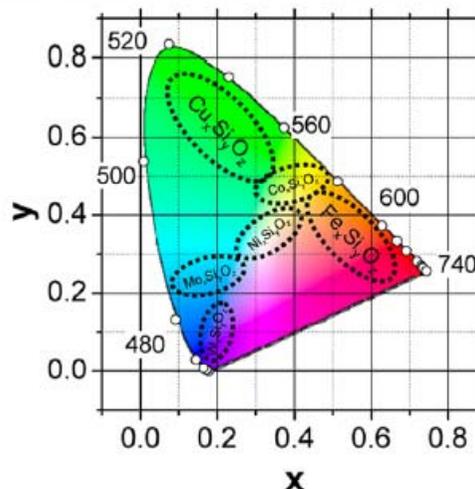
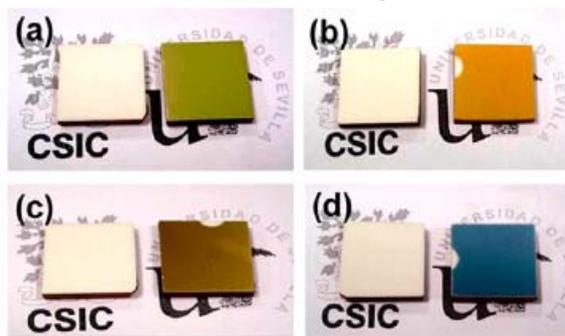
(Omega Optical Inc.)



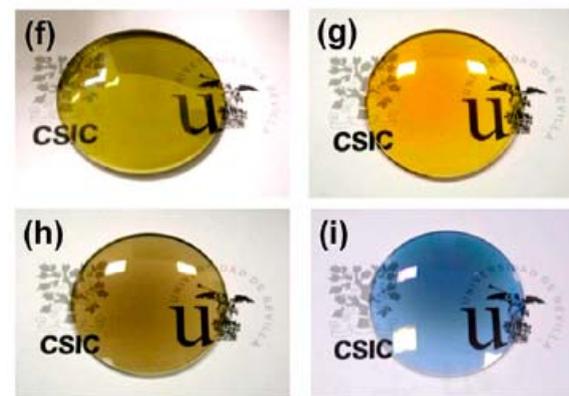
Intrinsically coloured. Amorphous mixed oxide $M_xSi_yO_z$ thin films (M: Fe, Ni, Co, Mo, W, Cu) for optical, coloring, and aesthetic applications. Specific colors can be selected by adjusting the plasma gas composition and the Si-M ratio in the magnetron target. M cations are randomly distributed within the SiO_2 amorphous matrix and that both the M concentration and its chemical state are the key parameters to control the final color of the films.

$M_xSi_yO_z$ thin films have been prepared by **reactive MS using a silicon target on which a series of metal strips have been arranged axially.**
 Geometry: Substrates placed parallel to the magnetron.
 Power: 100–300 W and pulsed DC voltage of 250–500 V at a frequency of 80 kHz.
 Deposition pressure: 5.0×10^{-3} mbar.
 Process gas: O_2/Ar mixtures with mass flow ratios from 0.05 to 2.5 depending on the type of thin film.

Coloured ceramic plates

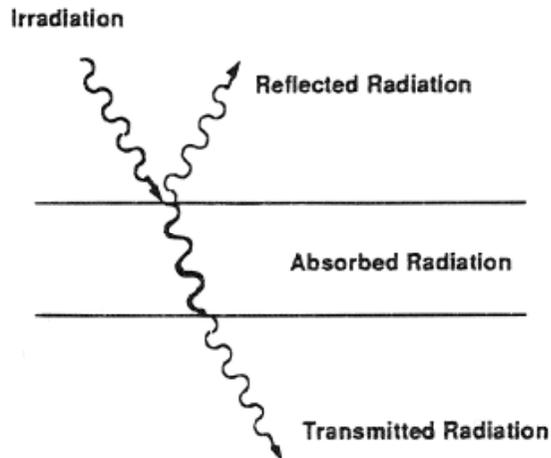


Colour coordinates diagram



Coloured polymeric ophthalmic lenses

Light Absorbance / Reflection



Solar absorptance. Solar radiation-absorption (α). The ratio of absorbed to incident radiation in the solar spectrum region.

Emittance, thermal infrared radiation-emission (ε). The energy radiated by the surface of a body per second per unit area

Kirchhoff's law recognized the experimental observation that a good absorber is a good emitter, and a poor absorber is a poor emitter. Naturally, a good reflector must be a poor absorber.

Black body, λ for which the intensity is maximal at a given T:

Wien's displacement law: $T \cdot \lambda_{\max} \approx 2.898 \times 10^6$

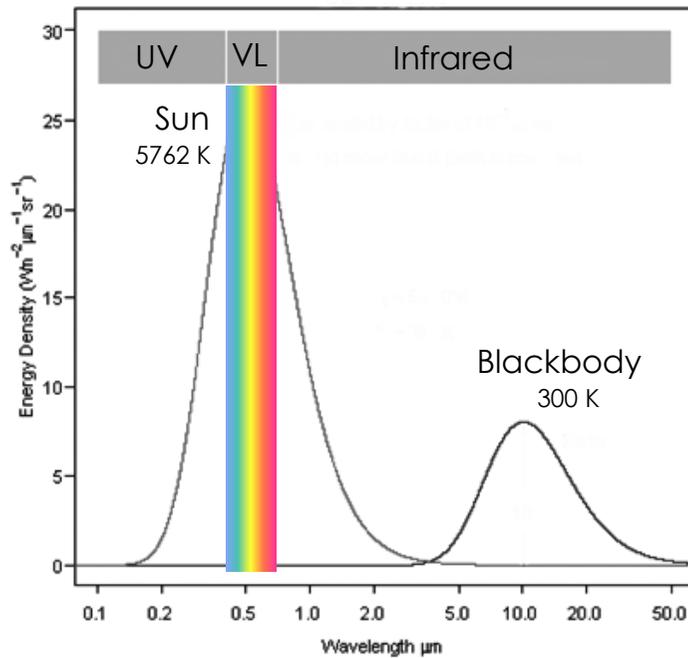
$T \rightarrow 523\text{K}$  $\lambda \rightarrow 5.5 \mu\text{m}$

$T \rightarrow 233\text{K}-373 \text{K}$  $\lambda \rightarrow 12.5 \mu\text{m} - 8 \mu\text{m}$

Dielectric Constant, Refractive Index. Reflectivity.

There is also a relation between optical and electrical properties in a material. For most naturally occurring materials at optical frequencies **the dielectric constant** (ε) is approximately the square of **the refractive index** (n^2).

High refractive index materials have in general high reflectivity in air.



Equilibrium temperature

$$T = 4 \sqrt{\frac{S\alpha}{4\epsilon\sigma}}$$

Stefan-Boltzmann's law

σ : Stefan-Boltzmann constant = $5.669 \times 10^{-8} \text{ W}\cdot\text{m}^{-2}\cdot\text{K}^{-4}$

S : solar constant = $1353 \text{ W}/\text{m}^2$

Solar absorptance

$$\alpha = \frac{\int_0^\infty \alpha_\lambda I_{\lambda,i} d\lambda}{\int_0^\infty I_{\lambda,i} d\lambda}$$

Thermal emittance

$$\epsilon = \frac{\int_0^\infty \epsilon_\lambda I_{\lambda b}(T) d\lambda}{\int_0^\infty I_{\lambda b}(T) d\lambda}$$

$I_{\lambda,i}$: incident spectral solar intensity

$I_{\lambda b}$: temperature-dependent spectral blackbody intensity

For opaque coatings

$$\epsilon_\lambda = \alpha_\lambda = 1 - \rho_\lambda \quad \text{Kirchhoff's law}$$

Selective surfaces

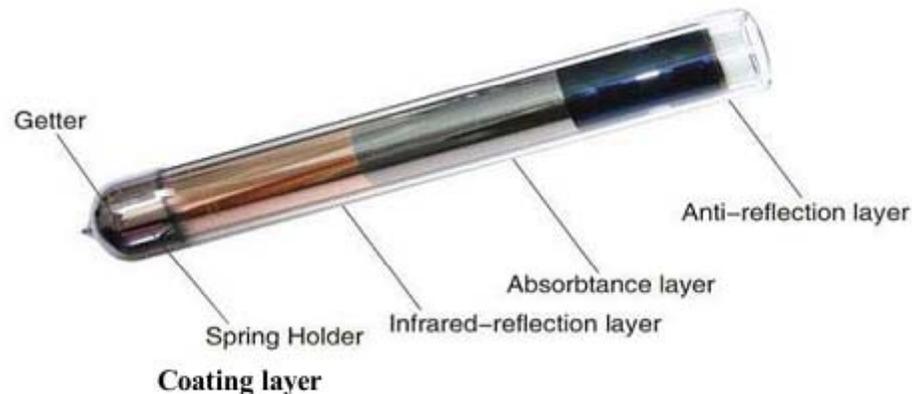
In solar thermal collectors, a **selective surface** or **selective absorber** is a means to increase its operation temperature and/or efficiency.

The selectivity is defined as the ratio of solar radiation-absorption (α) - to thermal infrared radiation-emission (ε).

Selective surfaces take advantage of the **different wavelengths range** of incident solar radiation and the emissive radiation from the absorbing surface:

Solar radiation covers approximately the wavelengths 350 nm - 4.000 nm (UV-A, visible and near infrared (NIR) or IRA+IRB).

Thermal infrared radiation, from materials with temperatures approximately in the interval -40 - 100°C, covers approximately the wavelengths 4.000 nm-40.000 nm = 4 μ m-.40 μ m. The thermal infrared radiation interval being named or covered by: MIR, LWIR or IR-C.



Maximize solar absorptance
&
Minimize thermal emission

Selective surfaces

Anodic Solar absorbers. Magnetron sputtering based coatings (less environmental polluting than electrochemical coatings) based on DC reactive sputtering. Graded Al-N or Mo-Al₂O₃ cermet coatings based on conventional magnetron sputtering.

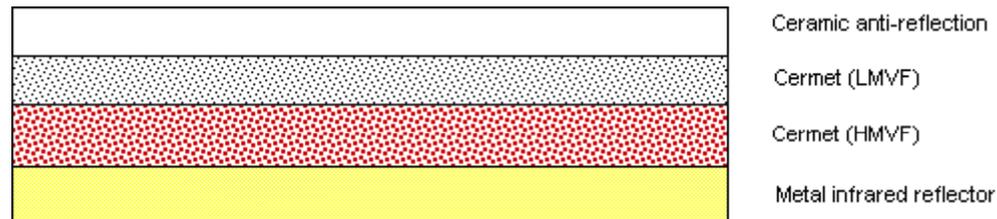
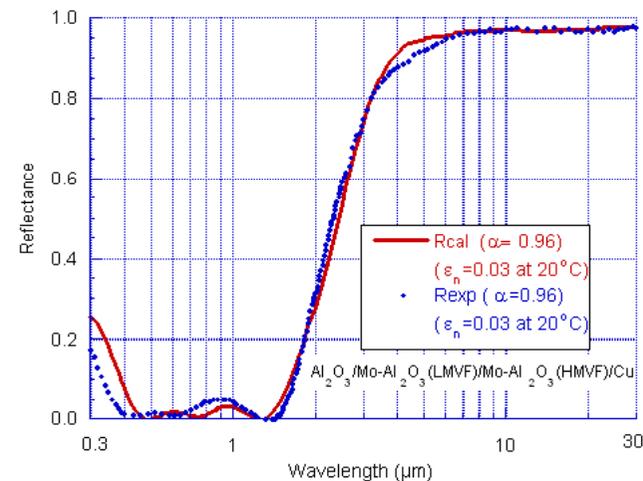
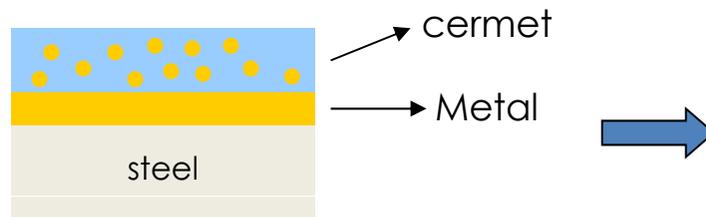


Fig.1. Schematic diagram of a solar selective absorber with double cermet layers, a low metal volume fraction (LMVF) cermet layer on a high metal volume fraction (HMVF) layer on a metal infrared reflector with a ceramic anti-reflection layer.

Highly absorbing coating in the VIS (black) and transparent in the IR

Cermet: Ceramic metal composites



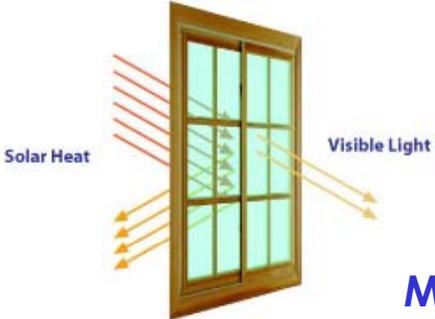
$Ti_{1-x}Al_xN(O)$ coatings with selective IR reflectivity



TiN \xrightarrow{x} AlN
metallic \xrightarrow{x} dielectric
Changes in optical properties
IR reflectivity

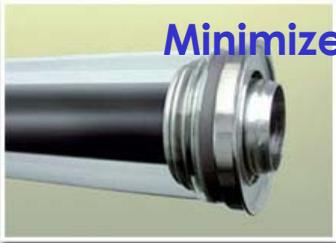
Satellite temperature control

V.Godinho, A.Fernández, et al.
Solar Energy., 84, 2010, 1397- 1401.

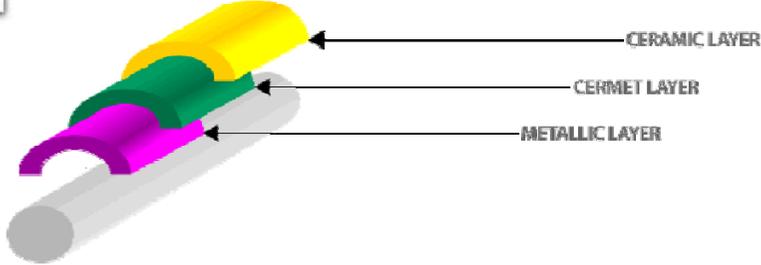


Solar-control windows

Maximize solar absorptance & Minimize thermal emission



Solar absorbers

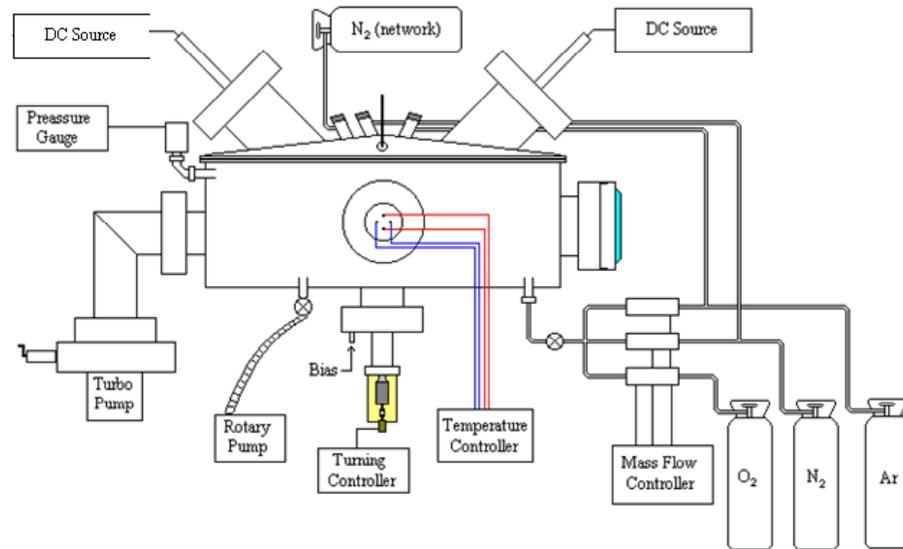
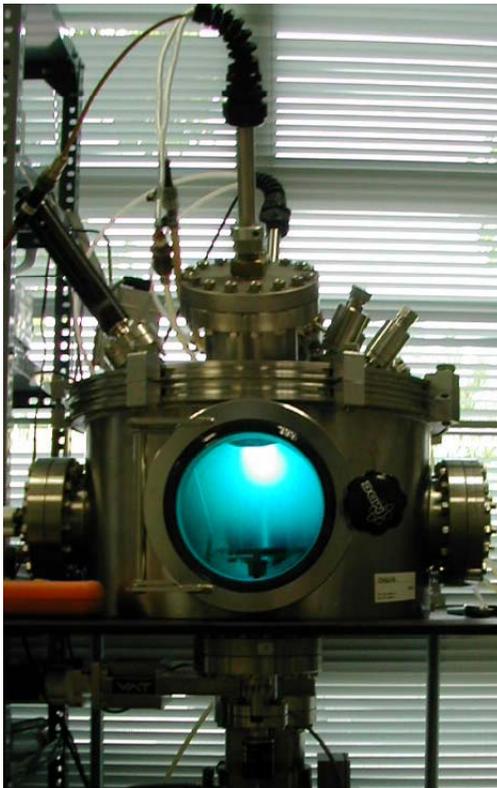


Maximize solar absorptance & High thermal emission

PVD by reactive magnetron sputtering

Substrates:

AISI 316-R steel, ALUSI steel, Silicon (100), NaCl, Quartz and Glass



Pure Ti target, 99.995%

Pure Al target 99,9995%

N₂+Ar reactive gas

} variable film composition

TiAlN coatings thickness

Sample	Ti	Al	%N2	t (min)	Profilometry	SEM fractography	Dep. rate (SEM)
TiAlN20	200	400	30	5	45 nm	60 nm	12 nm/min
TiAlN21	400	400	30	4	35 nm	80 nm	20 nm/min
TiAlN22	400	200	30	5	50-100 nm	75 nm	15 nm/min
TiAlN23	400	400	70	4	-	45 nm	11 nm/min
TiAlN24	400	400	15	4	100-140 nm	170 nm	42 nm/min
TiAlN25	200	400	15	5	80-120 nm	150 nm	30 nm/min
TiAlN26	600	400	15	4	140 nm	260 nm	65 nm/min
TiAlN27	400	600	15	5	135-230 nm	271 nm	54 nm/min
TiAlN28	200	600	15	5	105-170 nm	180 nm	36 nm/min
TiAlN29	400	200	15	5	-	235 nm	47 nm/min
TiAlN30	600	200	15	4	-	205 nm	51 nm/min
TiAlN31	600	600	15	3,5	-	202 nm	58 nm/min
TiAlN32	200	200	15	5	-	52 nm	10 nm/min

The deposition rate increases:

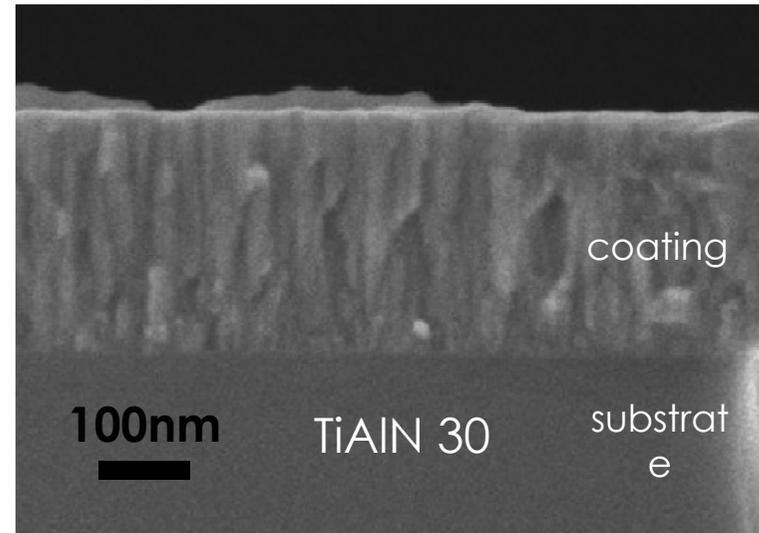
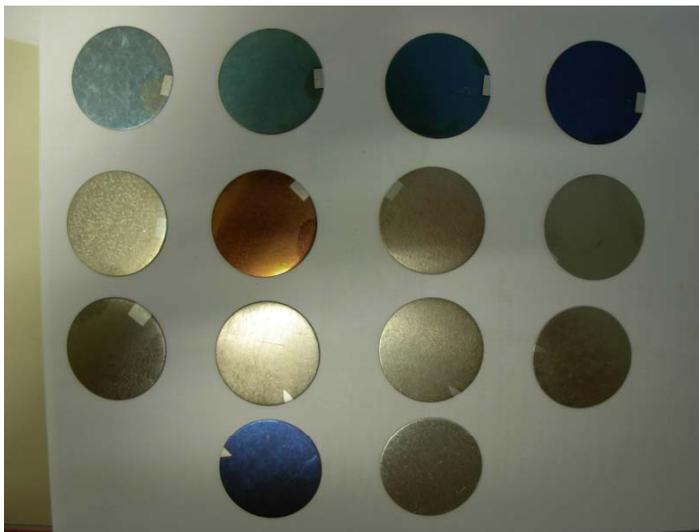
- by increasing the power supplied
- by decreasing the N2% ratio, the thickness decrease (TiAlN21, 23 and 24)

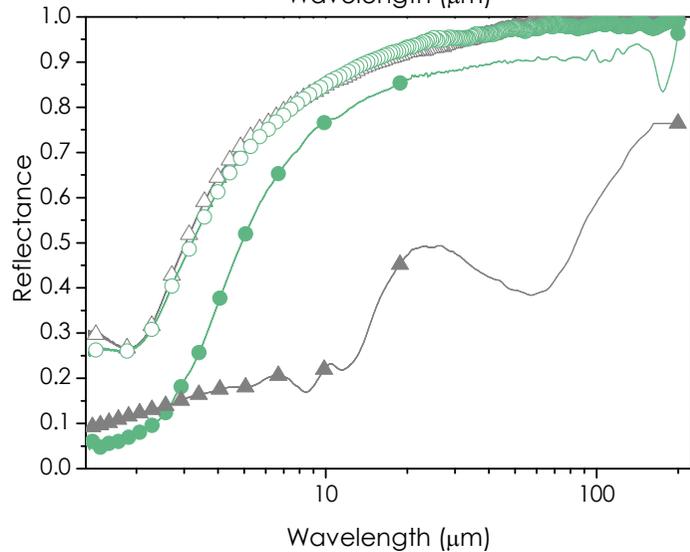
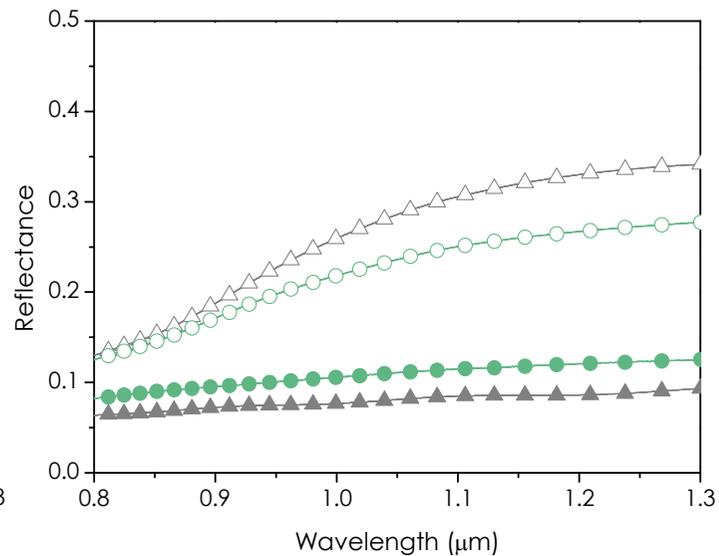
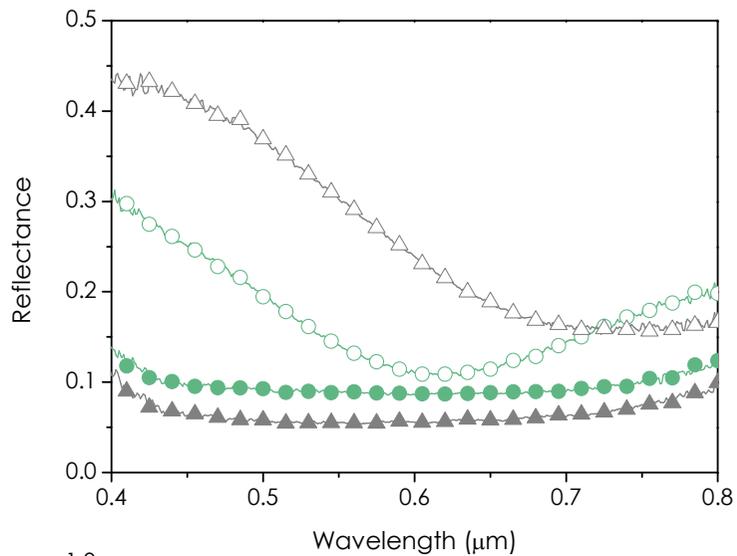
TiAlN coatings color



➤ blue-purple for transparent and very thin film

➤ grey-brown is the intrinsical colour





- △ X=0.60 t=60nm
- X=0.28 t=50nm
- X=0.28 t=1200nm
- ▲ X=0.60 t=1900nm

Solar absorbers

Satellite temperature control

X in $Ti_{1-x}Al_xN$	Thickness (nm)	α	ϵ	α/ϵ	Equilibrium temperature (°C)
0.28	1200	0.90	0.24	4.08	114
	50	0.84	0.15	5.40	150
0.60	1900	0.93	0.72	1.29	24
	60	0.79	0.15	5.00	142

Reflectance Spectra

V.Godinho, A.Fernández, et al.
Solar Energy., 84, 2010, 1397- 1401.

Porous silicon

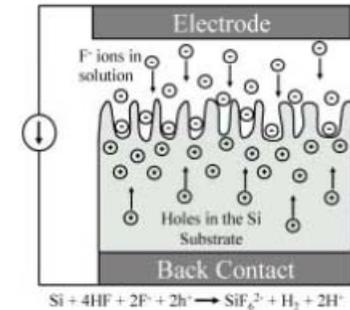
Photonic devices

Microelectronics

Solar energy conversion

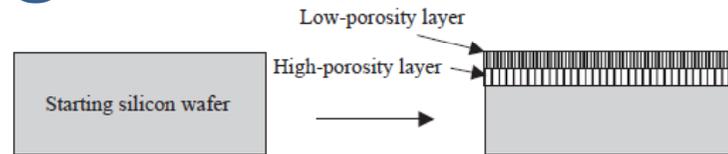
Up to now

1 Commonly produced by electrochemical methods

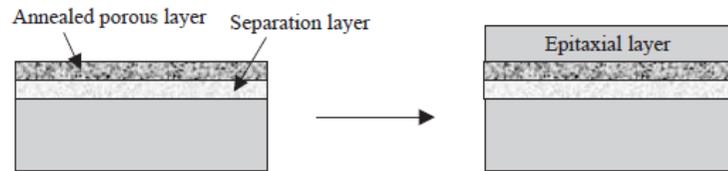


Changing electrolyte concentration and current, different structures are obtained

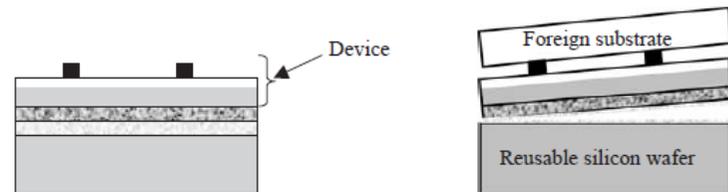
2 Transfer to less expensive substrates



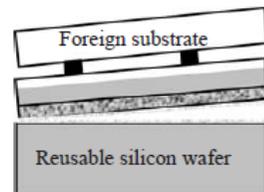
(a)



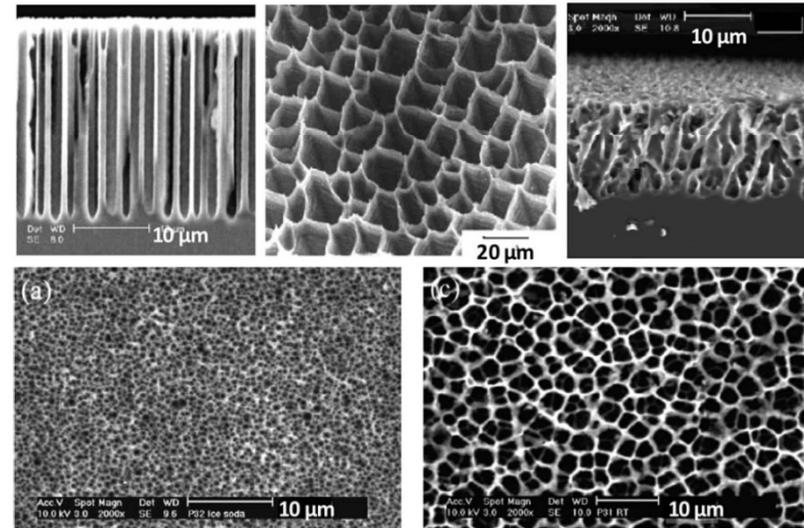
(b)



(c)



(d)



G.Korotcenkov, B.K. Cho

Silicon porosification: State of the Art

Critical Reviews in Solid State Materials Sciences, 35(2010)153-260

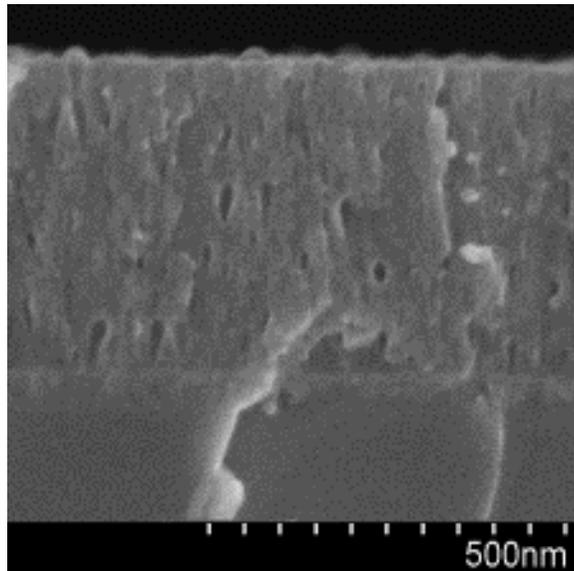
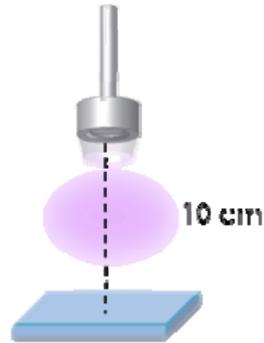
C.S. Solanki, R.R. Bilyalov, J. Poortmans, J. Nijs, R. Mertens

Porous silicon layer transfer processes

for solar cells, Solar Energy Materials & Solar Cells 83 (2004) 101-113

New method Control of the microstructure in the Nanoscale

magnetron sputtering
150W rf
He atmosphere



OPEN ACCESS
IOP PUBLISHING

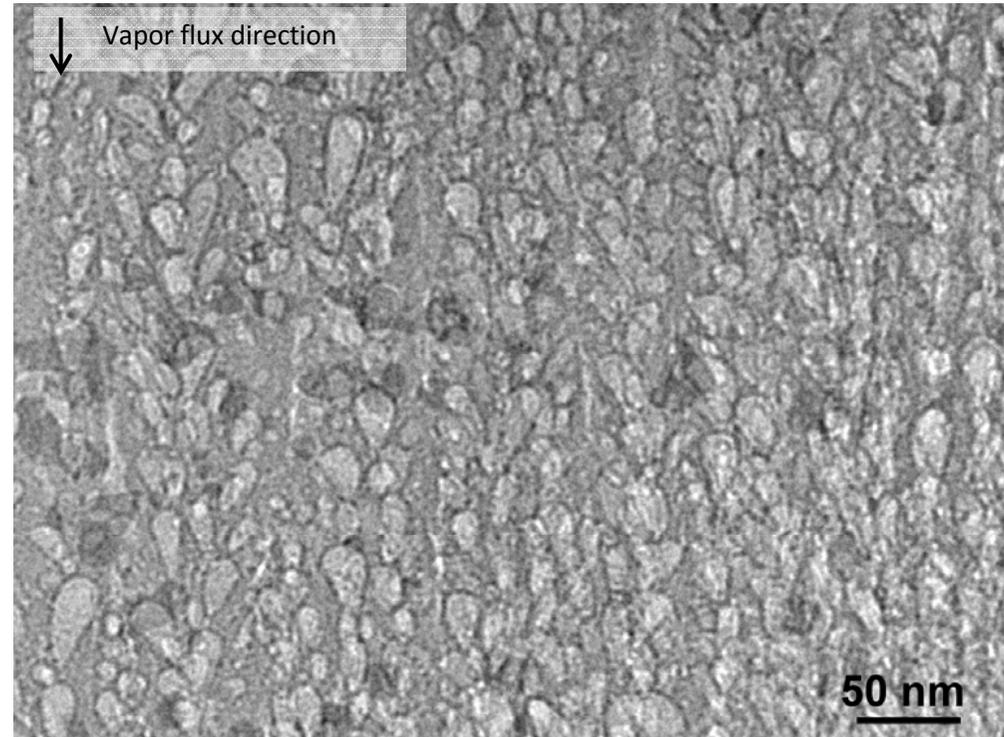
Nanotechnology 24 (2013) 275604 (10pp)

NANOTECHNOLOGY

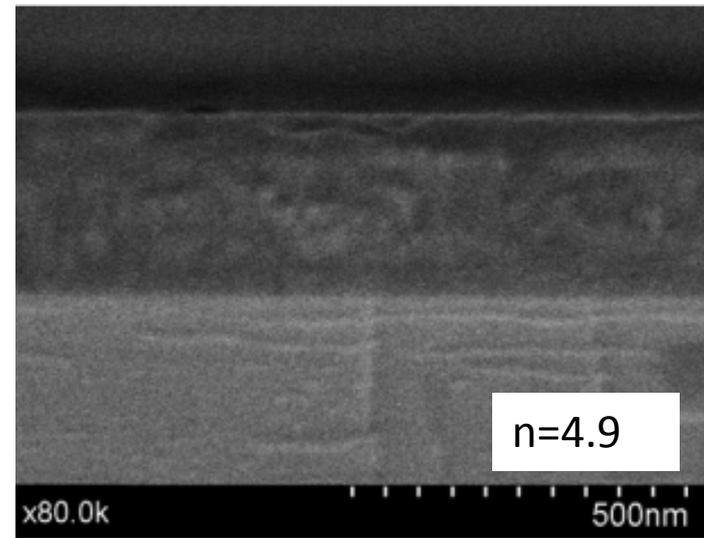
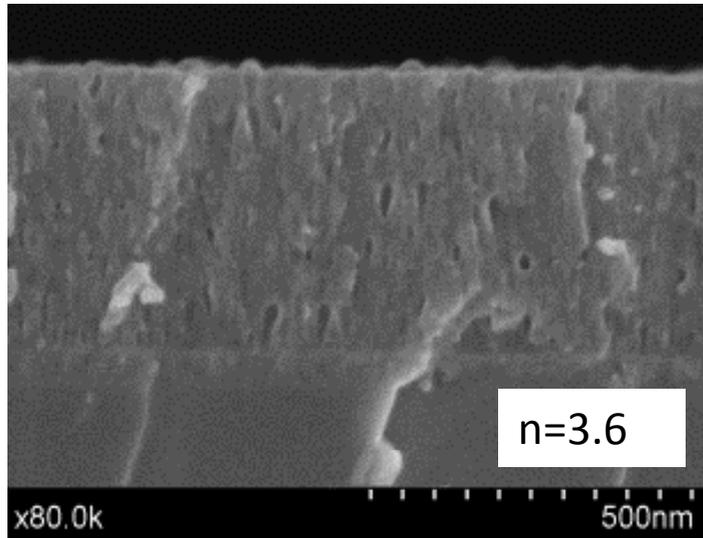
doi:10.1088/0957-4484/24/27/275604

A new bottom-up methodology to produce silicon layers with a closed porosity nanostructure and reduced refractive index

V Godinho¹, J Caballero-Hernández¹, D Jamon^{2,3}, T C Rojas¹,
R Shierholz¹, J García-López², F J Ferrer² and A Fernández¹



Porous Si coatings deposited by magnetron sputtering



material	$n_{500\text{nm}}$
c-Si	3.49
a-Si	4.90
PSi	3.5-1

- Handbook of Optics, 3rd edition, Vol. 4. McGraw-Hill 2009

OPEN ACCESS

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NANOTECHNOLOGY

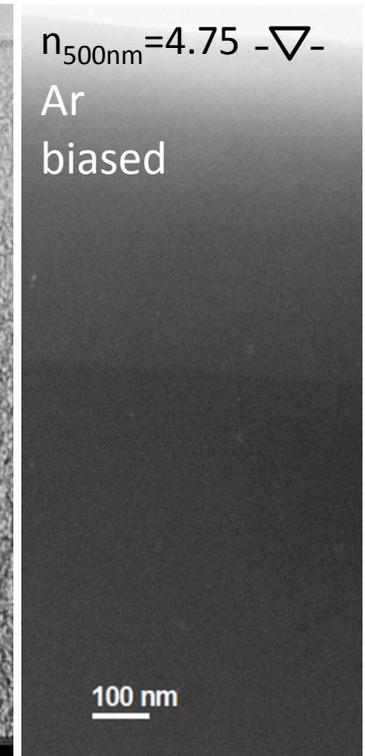
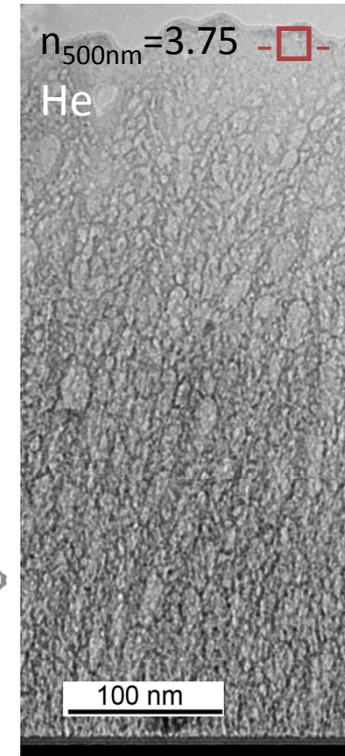
Nanotechnology 24 (2013) 275604 (10pp)

doi:10.1088/0957-4484/24/27/275604

A new bottom-up methodology to produce silicon layers with a closed porosity nanostructure and reduced refractive index

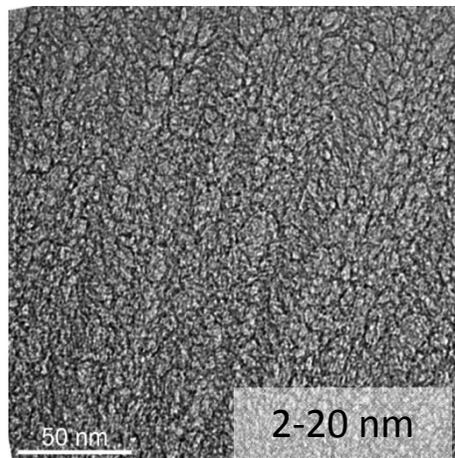
V Godinho¹, J Caballero-Hernández¹, D Jamon^{2,3}, T C Rojas¹, R Shierholz¹, J García-López⁴, F J Ferrer⁴ and A Fernández¹

Pores oriented in magnetron direction

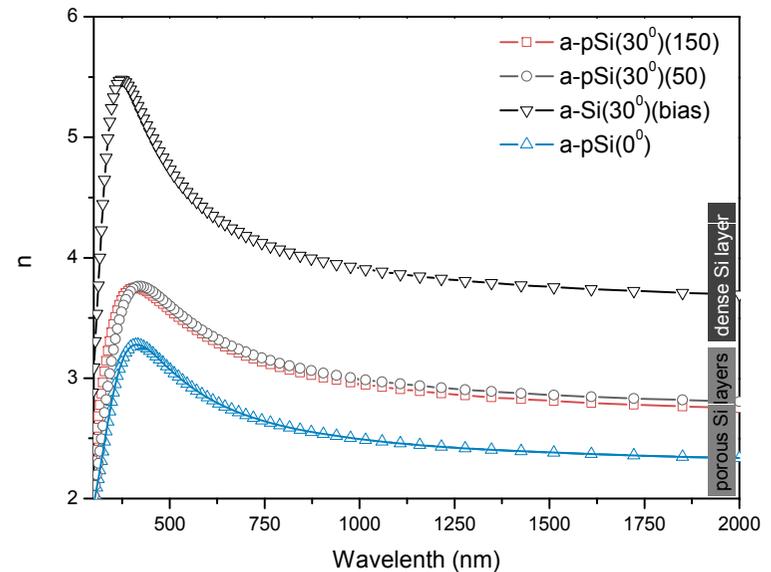
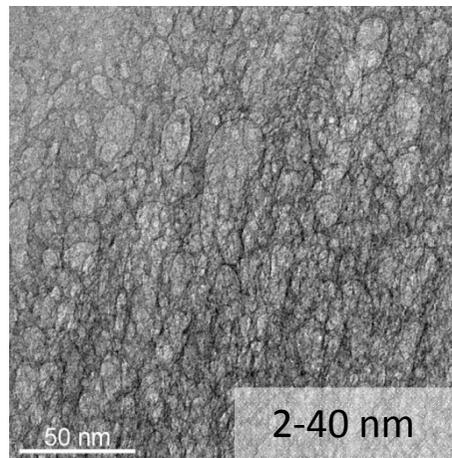


Pore size increases with increase of power

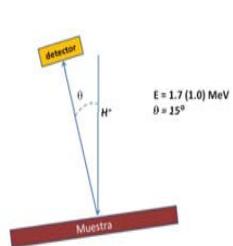
50W -○-



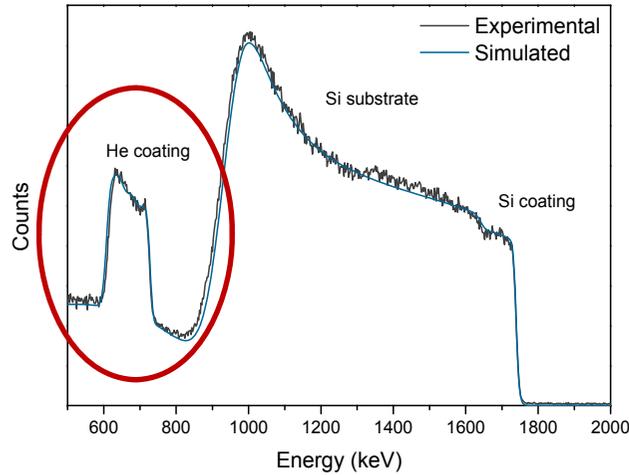
150W -□-



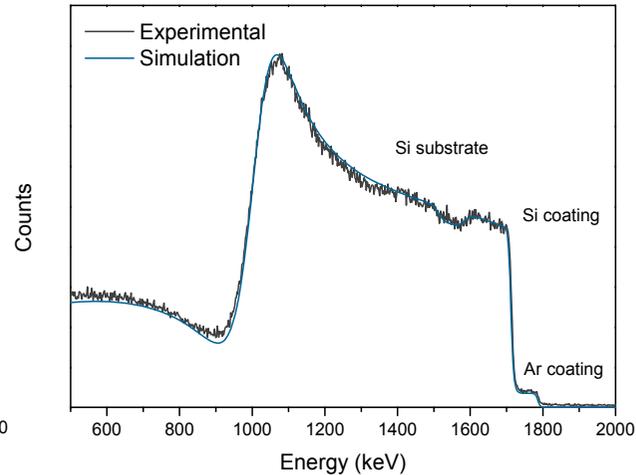
p-RBS measurements were performed with 1.7 MeV protons and a solid state detector located at 165° scattering angle



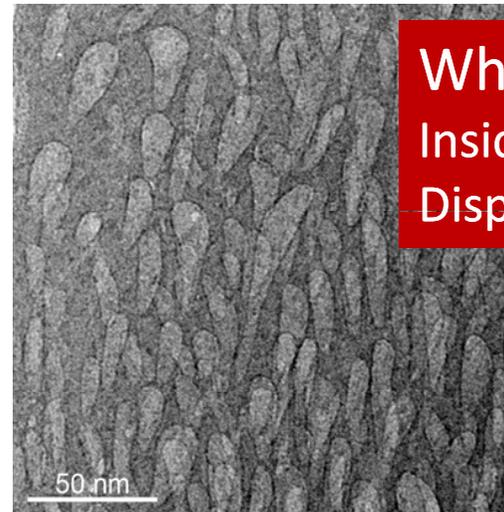
Porous coating



dense coating



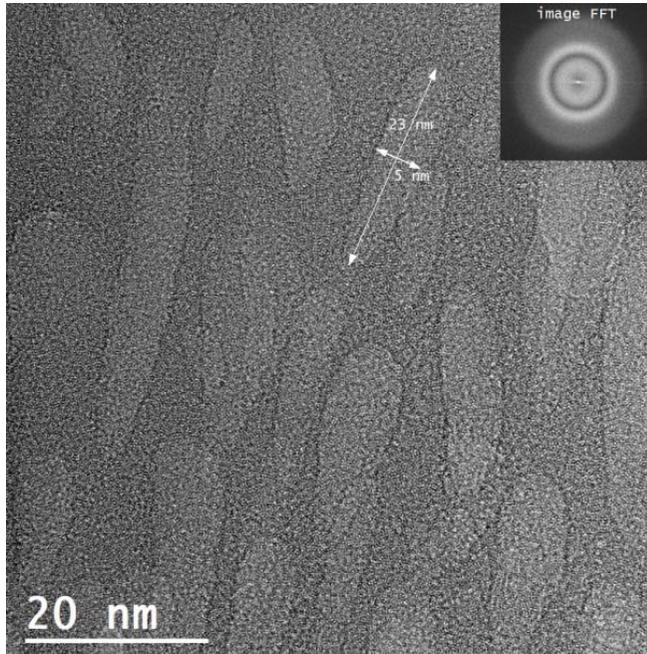
Sample	thickness (10 ¹⁵ at/cm ²)	Si (%at)	He (%at)	Ar (%at)
porous	11000	78.7	21.3	--
dense	9500	92.0	--	6.0



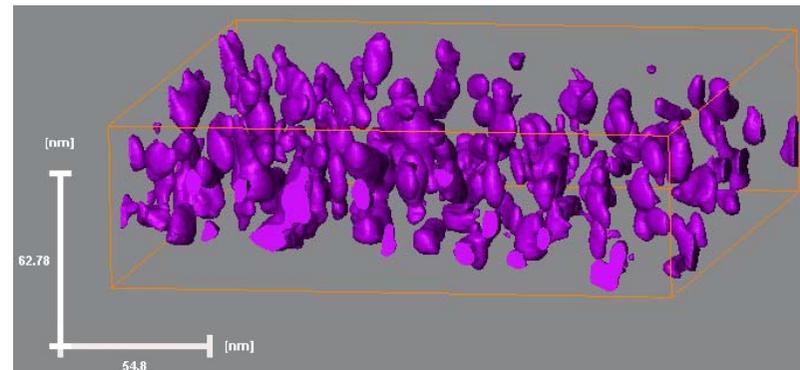
**Where is He?
Inside the pores?
Dispersed?**

He insolubility in metals is well known

High power and high pressure to increase pore size



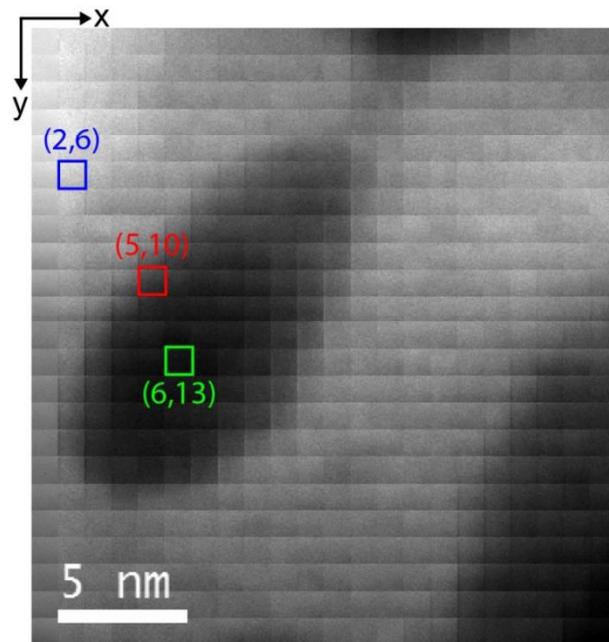
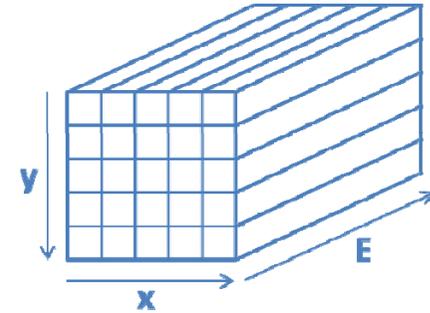
300W rf
4.8Pa He



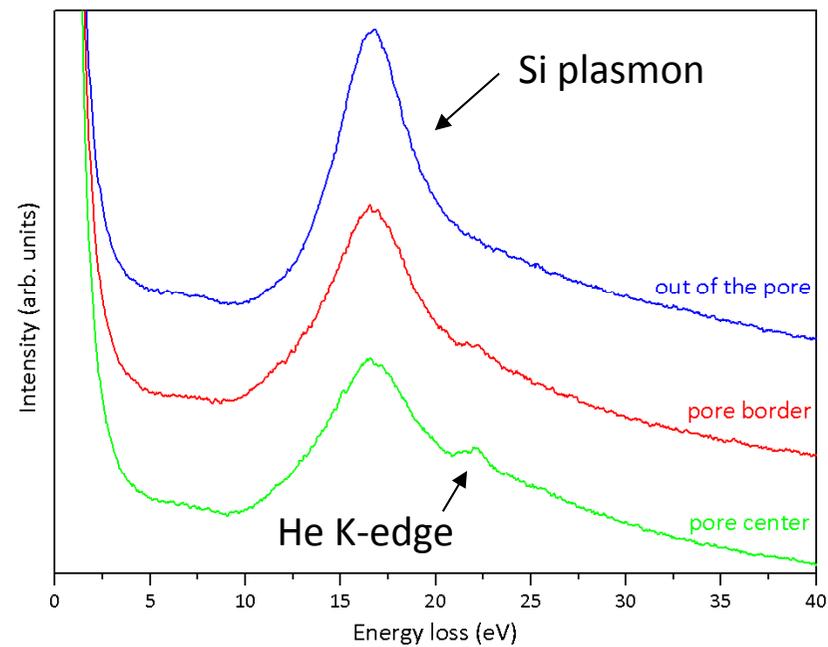
Need of **spatially resolved** analytical tools to be able to measure **He** signal **inside** and **outside** the pores

STEM-EELS

EELS spectra at various (i, j) positions of the sample. STEM-EELS spectrum images were recorded in the low loss range with a pixel size of 1 nm



HAADF image – Z contrast



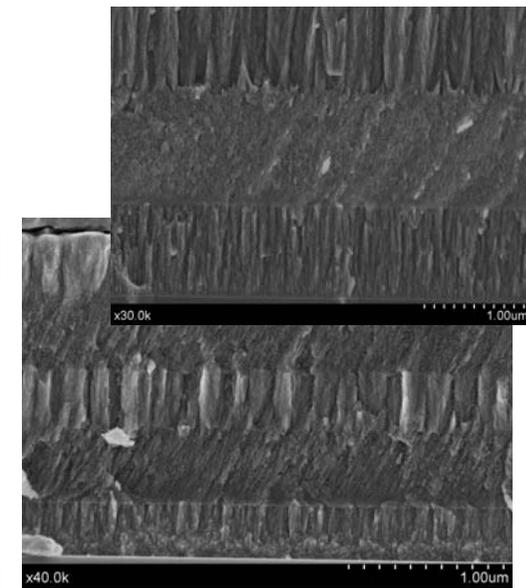
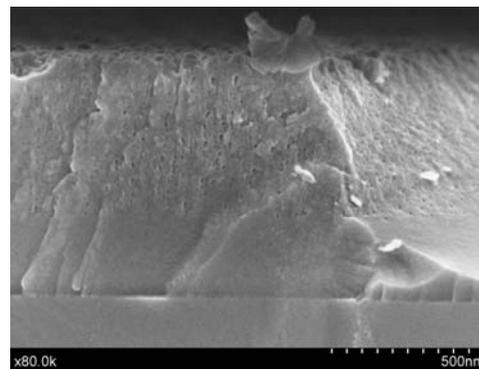
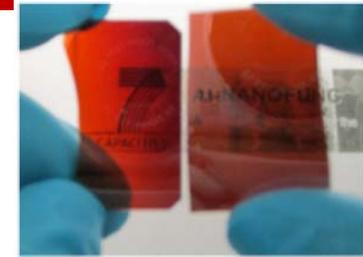
See more details at poster n°75

“Characterization of amorphous and porous silicon coatings by (S)TEM and EELS”

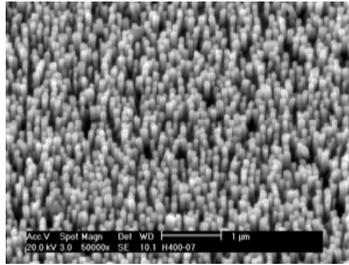
New bottom up method for the production of amorphous porous silicon coatings with closed porosity by magnetron sputtering

1st bottom up method with closed porosity

- Versatility of magnetron sputtering technique allows to produce coatings with **closed porosity** by depositing directly on large areas
- Depositing on different kinds of substrates like **glass** or even **sensible and flexible substrates** like polymers
- The closed porosity **avoids** the **aging drawbacks** due to exposition to air
- The **refractive index** of the coatings can be easily **changed** by controlling porosity
- Direct deposition of **multilayers** alternating **dense** and **porous** materials just by changing the deposition gas
- Deposition of intrinsic or doped silicon

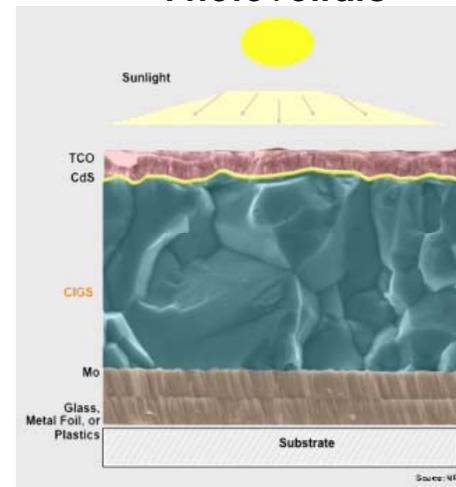


Functional: Electrical and optical



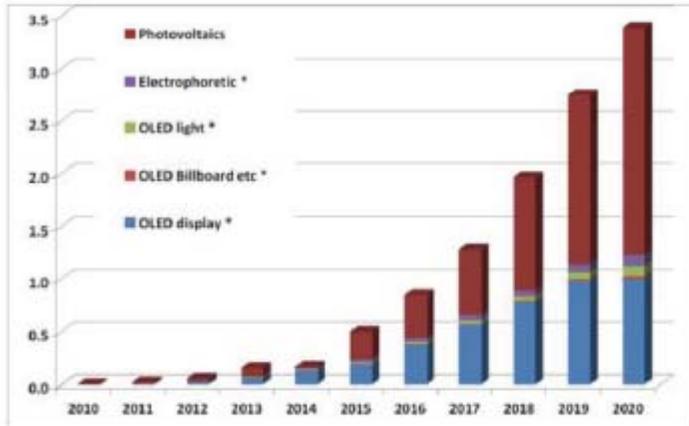
**vertically aligned ZnO
Nanowires. Transparent
& conductive coatings**

Thin film Photovoltaic



Transparent Conductive Electrodes

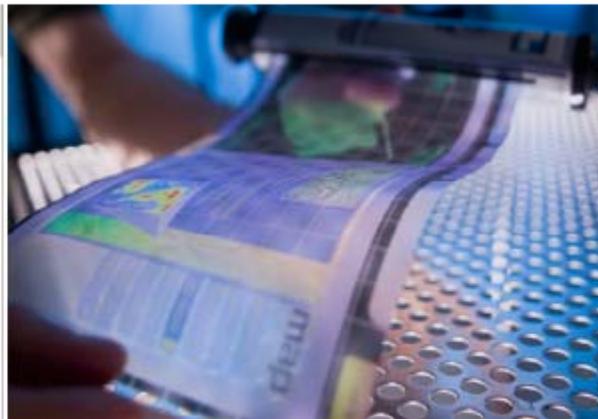
Applications of transparent conductive oxides (TCOs)



Source: IDTechEX



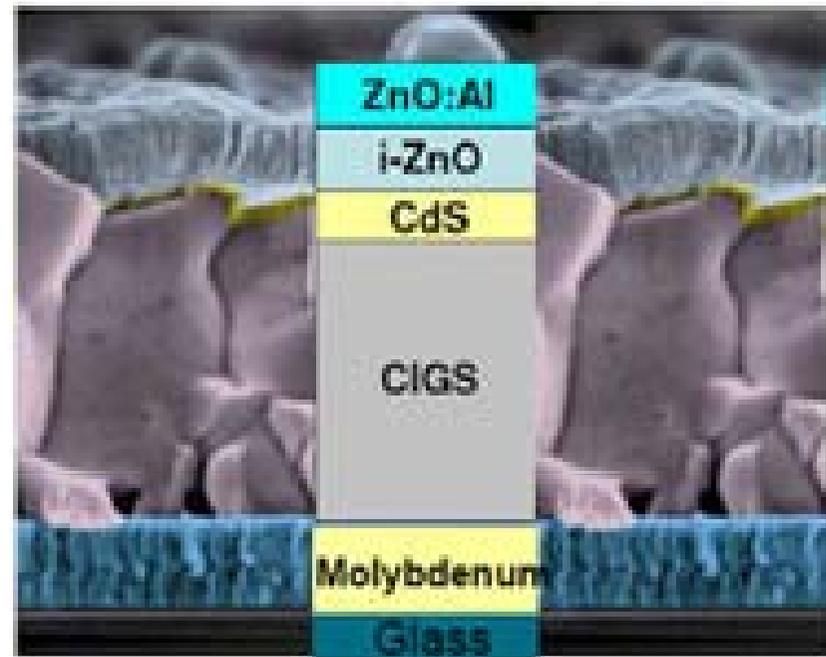
New applications: High flexible electronics (Prototypes of flexible computers (2013))



..... requires a replacement of TCOs. → Graphene is an excellent candidate!

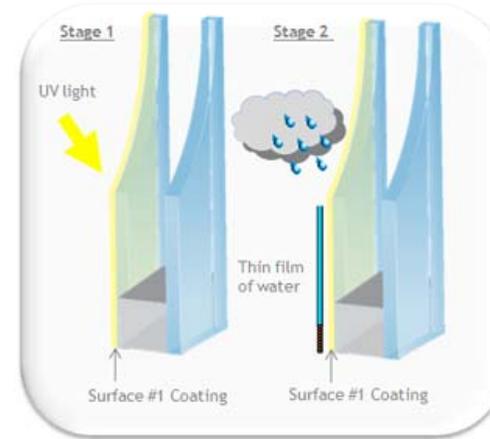
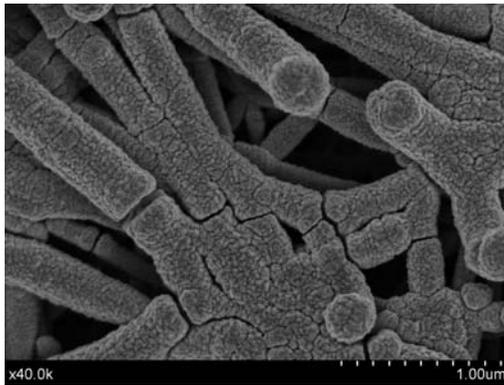
Copper indium gallium selenide ($\text{CuIn}_x\text{Ga}_{1-x}\text{Se}_2$ or CIGS) is a direct band-gap semiconductor useful for the manufacture of **solar cells**. Because the material has a high absorption coefficient and strongly absorbs sunlight, a much thinner film is required than of other semiconductor materials. Devices made with CIGS belong to the **thin-film** category of photovoltaic's (PV).

CIGS films can be manufactured by different methods:
The most common vacuum-based process is to **co-evaporate or co-sputter copper, gallium, and indium** onto a substrate at room temperature, then anneal the resulting film with a selenide vapor to form the final CIGS structure. An alternative process is to co-evaporate copper, gallium, indium and selenium onto a heated substrate.



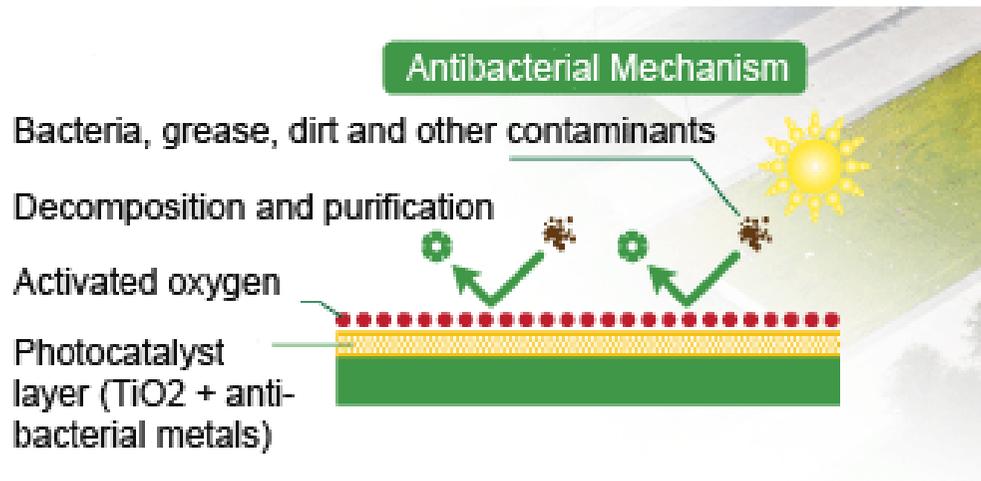
Catalytic coatings, self-cleaning

Co catalysts for
 H_2 generation



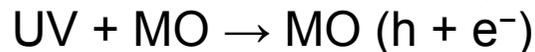
TiO₂ based self-cleaning coating

Photoatalytic thin Films

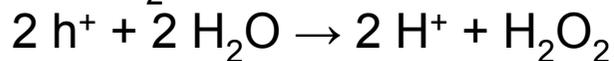
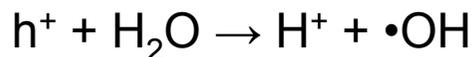


Heterogeneous photocatalysis

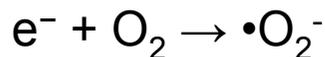
Oxidative reactions due to photocatalytic effect:



Here MO stands for metal oxide ---



The reductive reaction due to photocatalytic effect:



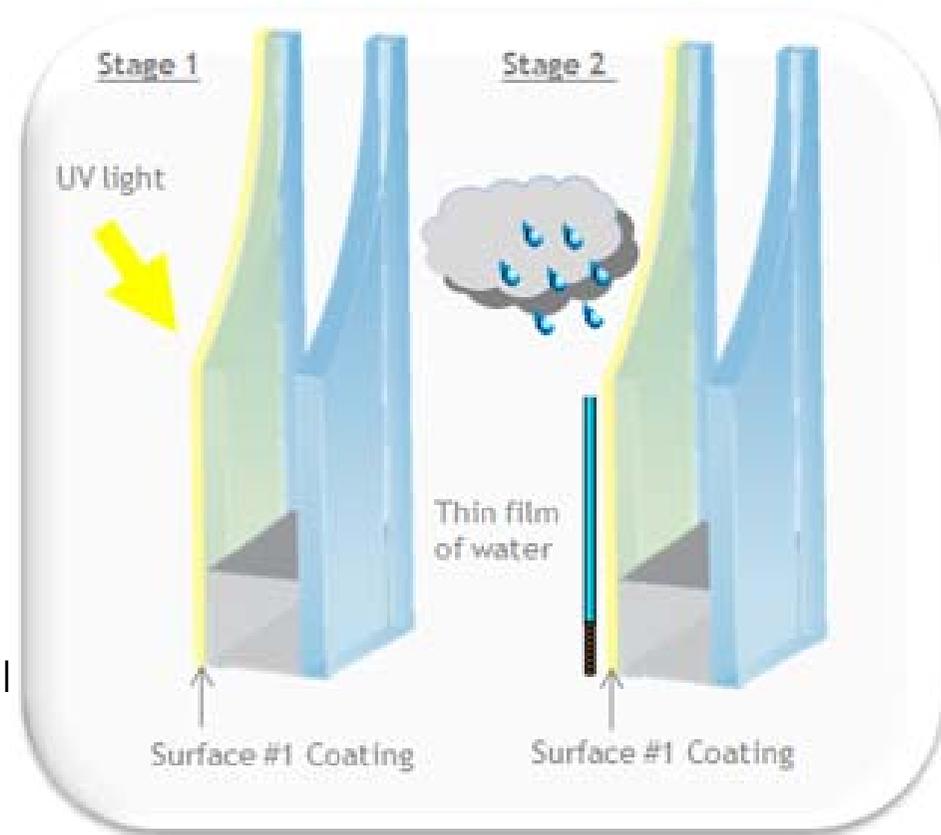
How self-cleaning glass works

Innovative photo-catalytic and hydrophilic coatings based on TiO_2 work in two stages

The unique dual-action self-cleaning coating is located on the external glass panel.

It has got photo-catalytic and hydrophilic properties, and works in two stages:

- (Stage 1) The coating reacts with natural daylight to break down and loosen organic dirt
- (Stage 2) When it rains, instead of forming droplets, the water spreads evenly over the surface of the glass, forming a thin film and helping to wash away any dirt and reduce streaks.



During long dry spells the glass can be cleaned by simply hosing it down with clean water.

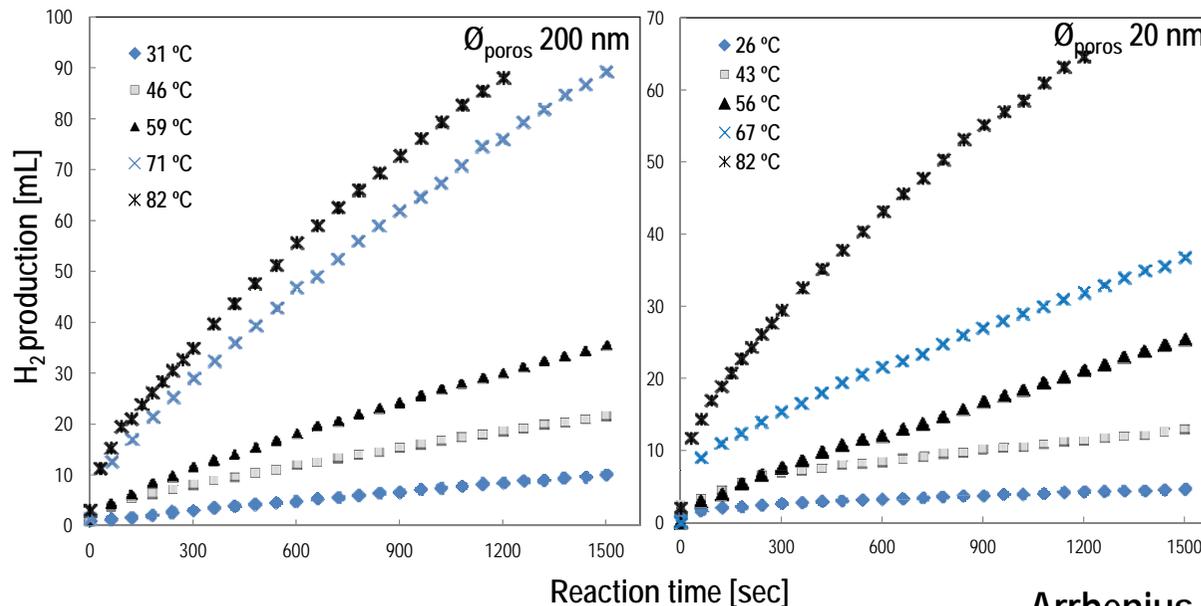
TiO_2 can be deposited by reactive magnetron sputtering from Ti target. But also from dip-coatings methodologies from the hydrolysis of Ti-isopropoxide precursors.

Hydrogen storage by NaBH₄



It is a safe hydrolysis reaction for hydrogen production in portable applications. The process is controlled by a catalysts.

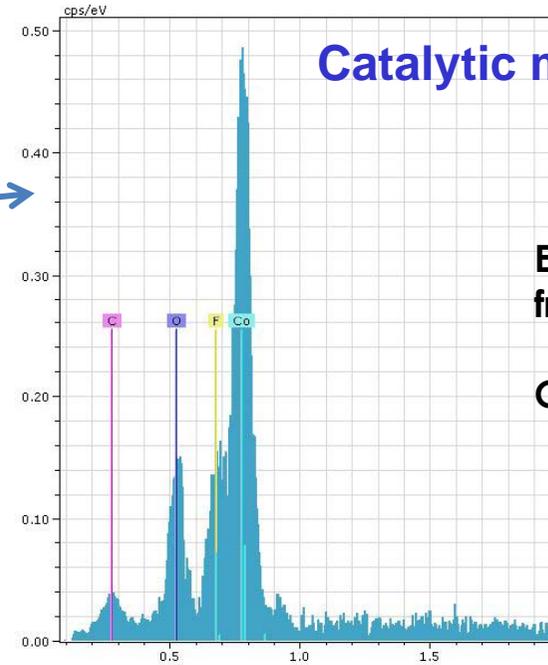
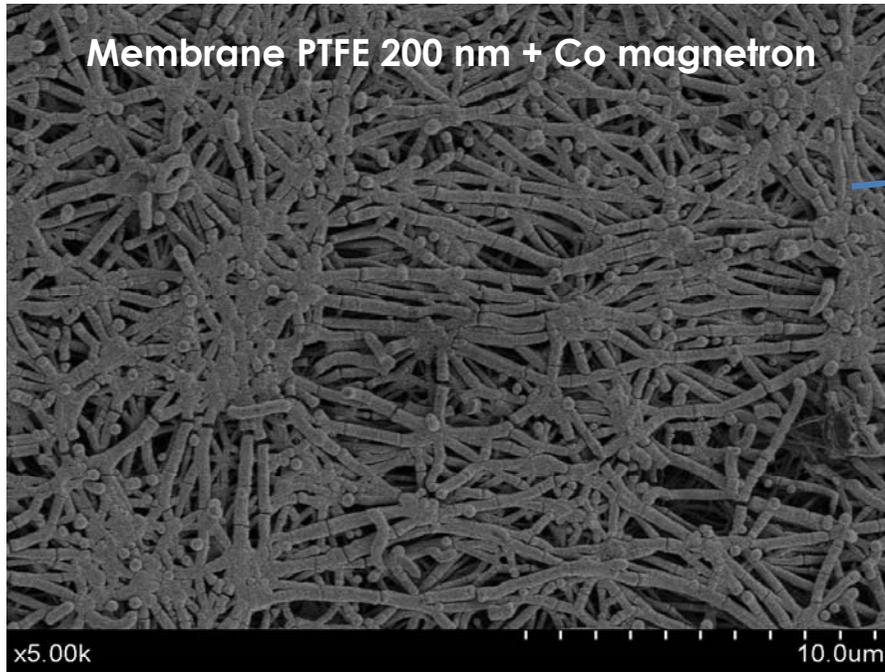
Development of **catalytic membranes** depositing Co-based catalysts by magnetron sputtering



Arrhenius-Plot:

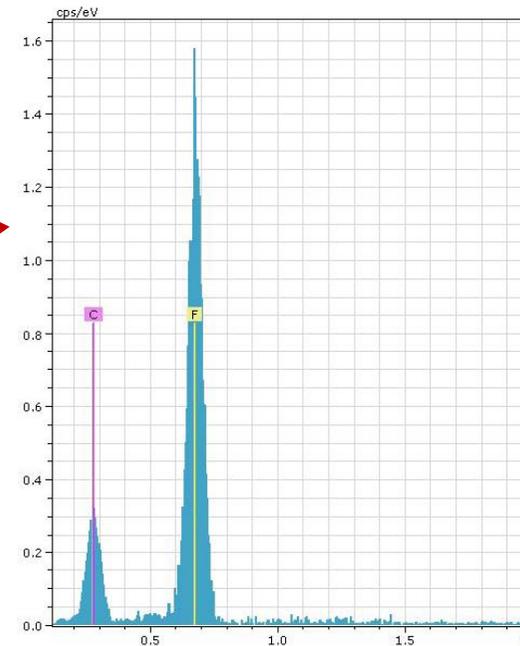
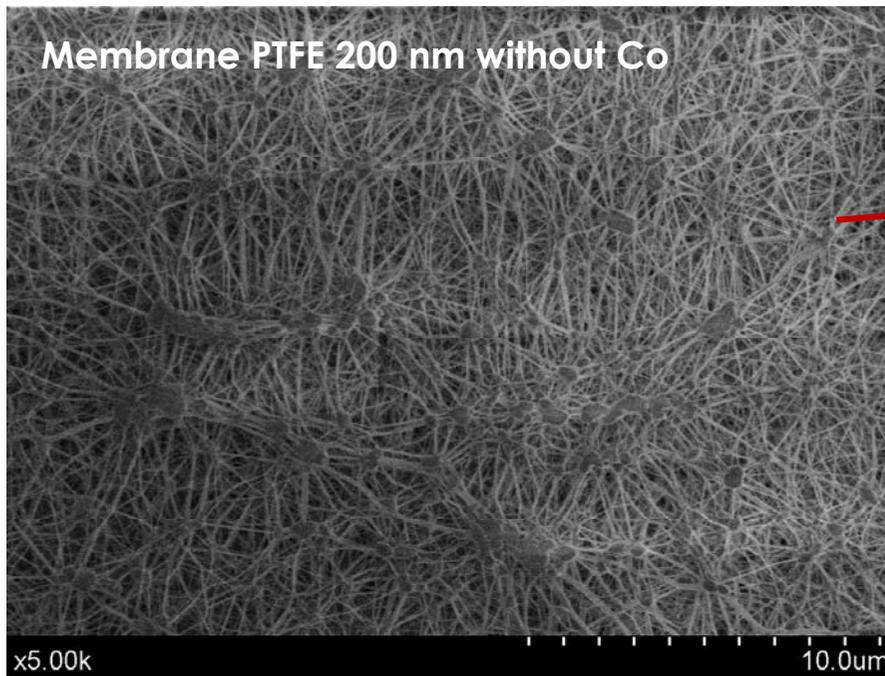
$$E_A \text{ } \varnothing_{\text{poros}} \text{ 200 nm} = 968,9 \text{ J/mol}$$

$$E_A \text{ } \varnothing_{\text{poros}} \text{ 20 nm} = 951,8 \text{ J/mol}$$



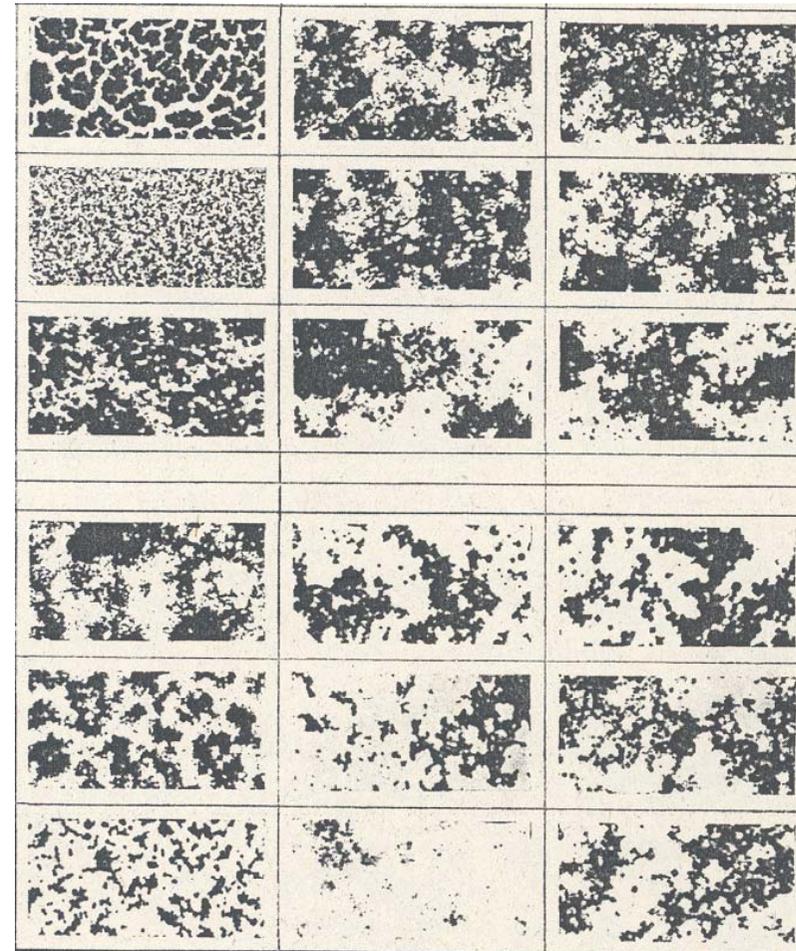
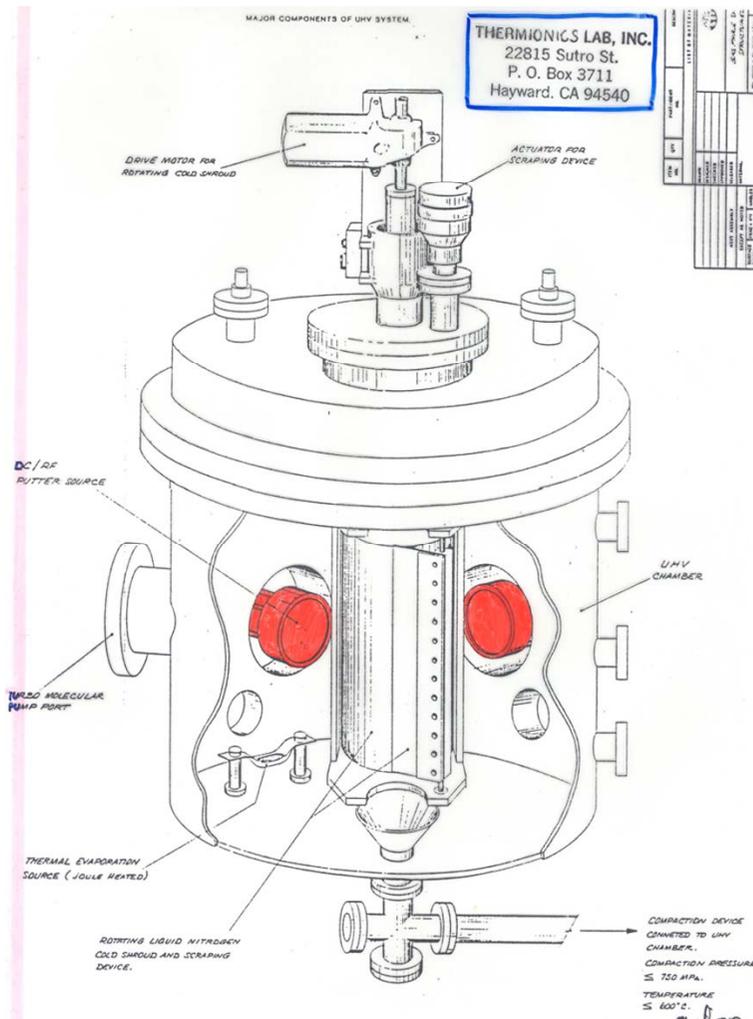
EDS: C and F
from PTFE.

Co catalysts



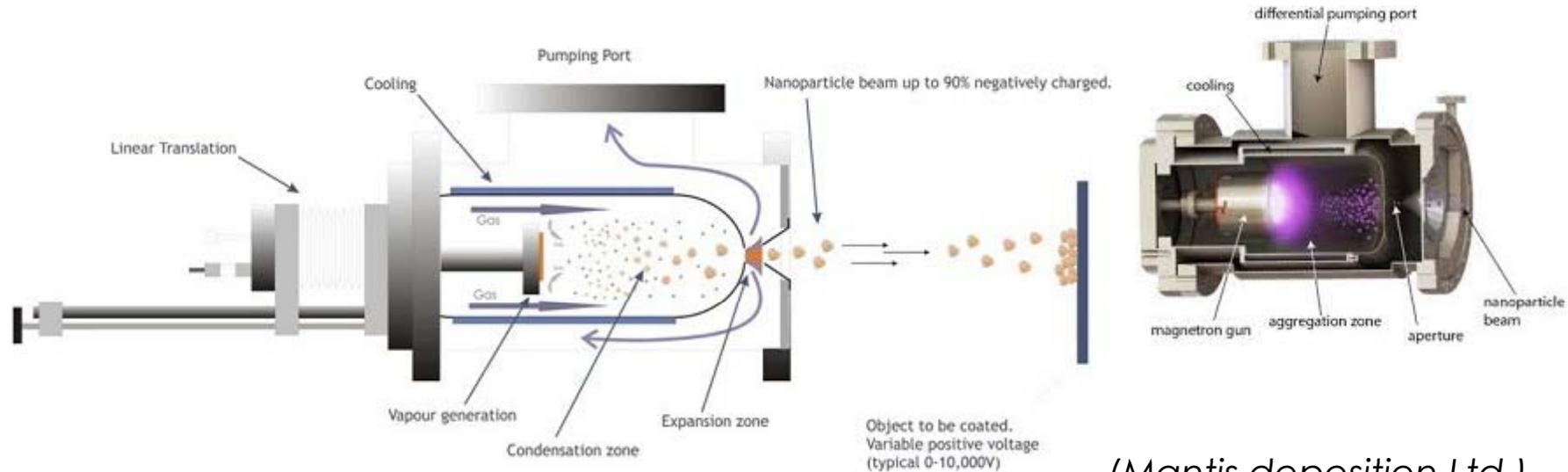
“Magnetron Sputtering” operated at high pressure

The process leads to more granulated or even powdered like materials. Magnetron coupled to a screaper device. Powder is collected below and compacted. Gas phase condensation. Formation of particles in the plasma gas phase by nucleation and growth



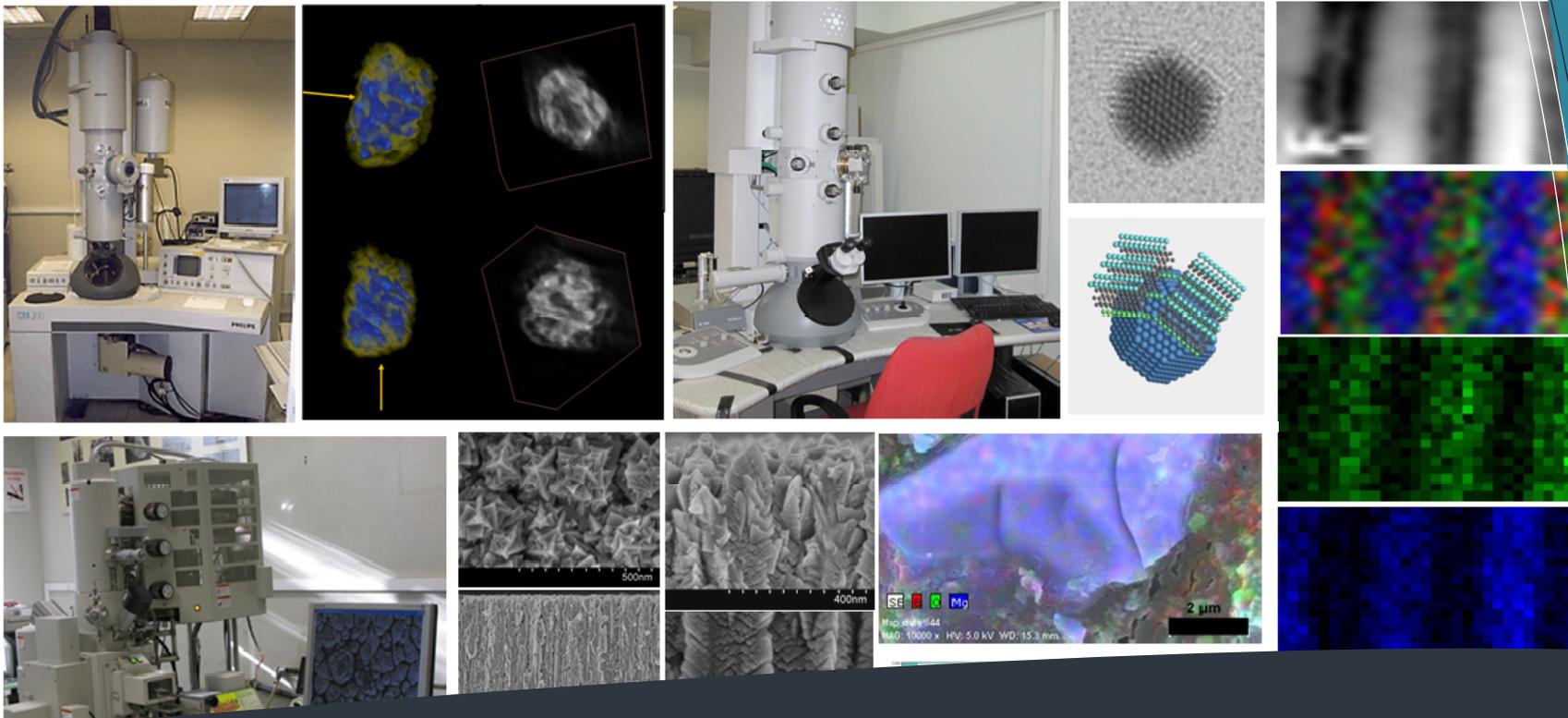
“Cluster source”

A sputtering source for “evaporating” the material from the target



(Mantis deposition Ltd.)

“Terminated cluster growth” is a physical vapor deposition technique that allows fabrication of metallic and conducting oxide nanoparticles with a very narrow size distribution. This type of source operates on the principle of quenching a hot metal vapor in a flowing stream of cool inert gas. The supersaturated vapor cools down due to frequent collisions with inert gas atoms, which leads to condensation and formation of clusters and nanoparticles.



LANE

Laboratorio Avanzado de Nanoscopias y Espectroscopias

